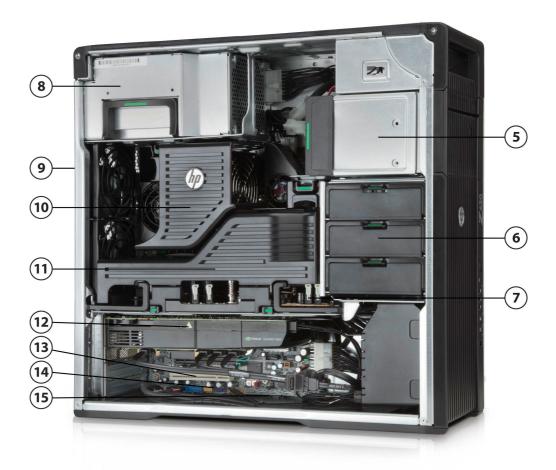
Overview



- 1. 2 External 5.25" Bays (shown with optional slot-load optical drive)
- 2. Power Button
- 3. HDD Activity LED
- 4. Front I/O: 1 USB 2.0, 2 USB 3.0, 1 Headphone, 1 Microphone, 1 1394a



Overview



- 5. 2 External 5.25" Bays
- 6. 3 Internal 3.5" Bays
- 7. 12 DIMM Slots for DDR3 ECC Memory
- 8. 800W, 90% Efficient Power Supply
- 9. Rear I/O: Rear Power Button & LED, PS/2 Ports, 1 1394a, 4 USB 2.0, 2 USB 3.0, 2 RJ-45 to Integrated GbE, 1 Audio Line In, 1 Audio Line Out, 1 Microphone
- 10. Intel Xeon Processors E5-1600 family or E5-2600 family

- 11. 2nd CPU & Memory Module
- 12. 2 PCIe x16 Gen3 Slots
- 13. 1 PCIe x8 Gen3, 1 PCIe x8(x4) Gen2, 1 PCIe x4(x1) Gen2, 1 PCI Slot
- 14. 6 Internal USB 2.0 Ports
- 15. 10 SATA Ports

Form Factor	Minitower
Operating Systems	Preinstalled:
	 Windows 7 Ultimate 64-bit* Windows 7 Professional 64-bit*



Overview

- Windows 7 Professional 32-bit*
- Windows 8 Pro 64-bit
- Windows 8 Simplified Chinese Edition 64-bit
- Windows 8 Pro Downgrade to Windows 7 Professional 32-bit
- Windows 8 Pro Downgrade to Windows 7 Professional 64-bit
- Windows 8.1 Pro 64-bit
- Windows 8.1 Simplified Chinese Edition 64-bit
- Windows 8.1 Pro Downgrade to Windows 7 Professional 32-bit
- Windows 8.1 Pro Downgrade to Windows 7 Professional 64-bit
- HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 5 & 6 and SUSE Linux Enterprise Desktop 11)
- Red Hat Enterprise Linux Desktop (Preinstall NOT available; 1 year paper license only)

Supported:

- Genuine Windows® 7 Enterprise 32/64
- SUSE Linux Enterprise Desktop 11
- Windows® XP Professional 32/64 (on select configurations)*

Notes: *See the "Windows XP Support Matrix for Z Workstations" at:

http://www.hp.com/support/workstation_manuals

Notes: For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux_hardware_matrix

Available Processors

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MHz)	QPI Speed (GT/s)	Hyper- Threading	Featuring Intel® vPro™ Technology	Intel® Turbo Boost Technology ¹	TDP (W)
Intel Xeon E5-2643 processor	4	3.3	10	1600	8.0	Y	Y	1, 2	130
Intel Xeon E5-2620 processor	6	2.0	15	1333	7.2	Y	Y	3, 5	95
Intel Xeon E5-2697 v2 processor	12	2.7	30	1866	8.0	Y	Y	3,8	130
Intel Xeon E5-2695 v2 processor	12	2.4	30	1866	8.0	Y	Y	4, 8	115
Intel Xeon E5-2690 v2 processor	10	3.0	25	1866	8.0	Y	Y	3, 6	130
Intel Xeon E5-2680 v2 processor	10	2.8	25	1866	8.0	Y	Y	3, 8	115
Intel Xeon E5-2670 v2 processor	10	2.5	25	1866	8.0	Y	Υ	4, 8	115



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Overview									
Intel Xeon									
E5-2667 v2	8	3.3	25	1866	8.0	Y	Y	3, 7	130
processor									
Intel Xeon									
E5-2660 v2	10	2.2	25	1866	8.0	Y	Y	4, 8	95
processor									
Intel Xeon								İ	
E5-2650 v2	8	2.6	20	1866	8.0	Y	Y	4, 8	95
processor	•						-		
Intel Xeon									
E5-2643 v2	6	3.5	25	1866	8.0	Y	Y	1, 3	130
processor		3.3				· ·			
Intel Xeon						 			
E5-2640 v2	8	2.0	20	1600	7.2	Y	Y	3, 5	95
processor	"	2.0		1000	/· -		·	3, 3	33
Intel Xeon									
E5-2637 v2	4	3.5	15	1866	8.0	Y	Y	1, 3	130
processor	"	3.5	13	1000	8.0	'	, r	1, 3	130
-									
Intel Xeon E5-2630 v2	_	٦.	15	1600		Y	Y	3.5	80
	6	2.6	15	1600	7.2	1	, Y	3, 5	80
processor					l			 	-
Intel Xeon	_			1.500		٠.,	.,		
E5-2620 v2	6	2.1	15	1600	7.2	Y	Y	3, 5	80
processor									
Intel Xeon	_								
E5-2609 v2	4	2.5	10	1333	6.4	N	Y	N/A	80
processor									
Intel Xeon								_	
E5-2603 v2	4	1.8	10	1333	6.4	N	Y	N/A	80
processor									ļ
Intel® Xeon®	6	3.3	15	1600	_	Y	Y	3, 6	130
E5-1660 processor		3.3				<u> </u>		3,0	130
Intel Xeon	6	3.2	12	1600	_	Y	Y	3, 6	130
E5-1650 processor		J.2	12	1000		'	<u> </u>	3,0	130
Intel Xeon	4	3.6	10	1600		Y	Y	2, 3	130
E5-1620 processor	-	3.0	10	1000	-	T	T T	2, 3	130
Intel Xeon	_	3.0	40	1000			v	N/A	130
E5-1607 processor	4	3.0	10	1066	-	N	Y	N/A	130
Intel Xeon			4.5	4000					4
E5-1603 processor	4	2.8	10	1066	-	N	Y	N/A	130
Intel Xeon									
E5-1680 v2	8	3.0	25	1866	_	Y	Y	4, 9	130
processor								.,,,	
Intel Xeon									
E5-1660 v2	6	3.7	15	1866	_	Y	Y	2, 3	130
processor		""	.,			·	·	-, 5	.50
p. 5003301						J		I	



Overview

Intel Xeon E5-1650 v2 processor	6	3.5	12	1866	-	Y	Y	1, 4	130
Intel Xeon E5-1620 v2 processor	4	3.7	10	1866	-	Y	Y	0, 2	130
Intel Xeon E5-1607 v2 processor	4	3.0	10	1600	-	N	Y	N/A	130

¹The specifications shown in this column represent the following: (all core maximum turbo steps, one core maximum turbo steps). Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A.

NOTE: Z620 systems configured with E5-1600 series processors may not add a 2nd processor. To support two processors, E5-2600 series processor must be chosen.

Available Processor Disclaimers

When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details

Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Additional Details

- Intel® Sandy Bridge Architecture
- Intel® C602 Chipset

Intel® Xeon® processor E5-2600 product family

Intel® Xeon® processor E5-2600 v2 product family

Intel® Xeon® processor E5-1600 product family

Intel® Xeon® processor E5-1600 v2 product family

(Sandy Bridge, Socket R)

- Up to 8.0GT/s QPI support with two QPI links between processors
- 4-channel per processor 1066/1333/1600/1866 MHz DDR3 memory* subsystem
- Up to 192 GB Memory capacity with 12 DIMM slots and 16 GB DIMMs (with two processors installed)
- PCI Express I/O and dual PCIe x16 Gen3 graphics support
- Dual Integrated Intel Gigabit LAN on Motherboard (LOM)
- 2 channels of Serial ATA (SATA) 6.0 Gb/s and 8 channels of SATA 3.0 Gb/s natively supported internally
- SATA RAID 0, 1, 5, and 10 support standard on motherboard
- SAS RAID 0, 1, and 10 supported using the LSI 9212-4i 6Gb/s controller
- SATA optical drives
- High Definition integrated audio with internal speaker
- 800W 90% efficient power supply
- ENERGY STAR® qualification and energy-saving features available on selected configurations (Not



Overview

I	supported by Linux)
	 supported by Linux) Protected by HP Services, including a 3 years parts, 3 years labor, and 3 years onsite service (3/3/3)
	standard warranty. Terms and conditions vary by country. Certain restrictions and exclusions apply.
	*Each processor supports up to 4 channels of DDR3 memory. To realize full performance at least 1 DIMM must be inserted into each channel. To get full 8 channel support, 2 processors MUST be installed.
Form Factor	4U Rackable Minitower
Color	Brushed aluminum & black
I/O Expansion Slots	Slot 1 (top): PCI Express Gen2 x4(1)* Full-height, Half-length (not available when 2nd CPU/Memory Module is installed)
	Slot 2: PCI Express Gen3 x16 Full-height, Full-length (with extender)
	Slot 3: PCI Express Gen2 x8(4)* with open-ended connector** Full-height, Full-length (with extender)
	Slot 4: PCI Express Gen3 x8 with open-ended connector** Full-height, Full-length (with extender)
	Slot 5: PCI Express Gen3 x16 Full-height, Full-length (with extender)
	Slot 6: PCI 32bit/33MHz Full-height, Full-length (with extender)
	* x <number> = number of lanes or size of the physical/mechanical connector. (number) = number of lanes supported electrically. Typically communicated as x# mechanical, x(#)electrical. ** open-ended connector allow a greater bandwidth (e.g. x16) card to be installed physically into a lower</number>
Mass Stevense Paus (see	bandwidth connector/slot.
Mass Storage Bays (see Storage section for more details)	Total bays = 5
Internal Bays	3 internal 3.5" bays (with acoustic dampening rail assemblies pre-installed)
External Bays	2 external 5.25" bays (4th HDD occupies one external bay)
Front I/O	2 USB 3.0, 1 USB 2.0, 1 Headphone, 1 Microphone, 1 IEEE 1394a
Rear I/O	2 USB 3.0, 4 USB 2.0, 2 RJ-45 integrated Gigabit LAN, 2 PS/2, 1 Audio Line-In, 1 Audio Line-Out, 1 Microphone Serial supported with optional connector on PCI bracket cabled to system board connector
Internal USB	6 USB 2.0 ports available by three separate 2x5 headers. Each 2x5 header supports either one HP Internal USB Port Kit (EM165AA) or one 22-in-1 Media Card Reader.



Overview

Chassis Dimensions (H v W	1/1 /E v 17 15 v /6 /9 cm /1	7 5 v 6 75 v 19 3 in)				
x D)	Rack utilization: 4U	44.45 x 17.15 x 46.48 cm (17.5 x 6.75 x 18.3 in)				
System Weight	Actual weight depends upor	configuration				
System weight	Minimum config: 15.5 kg (34					
	Typical config: 17.9 kg (39.4					
	Maximum config: 22.6 kg (4					
Temperature	Operating:	5° to 35° C (40° to 95° F)				
	Non-operating	-40° to 60° C (-40° to 140° F)				
Humidity	Operating:	8% to 85% relative humidity, non-condensing				
	Non-operating	8% to 90% relative humidity, non-condensing				
Maximum Altitude (non-	Operating:	3,048m (10,000ft)				
pressurized)	Non-operating	9,144m (30,000ft)				
Power Supply	Tool-free 800W 90% Efficie	nt wide-ranging, active Power Factor Correction				
	The Power Supply Efficiency	y Report for this product may be found at this link: TBD				
Interfaces Supported		(2 @ 6.0 Gb/s and 8 @ 3.0 Gb/s). 6 channels are eSATA configurable (2 @ 6 Gb/s,				
	4 @ 3 Gb/s) for use with eSATA CTO/AMO Kit.					
	SAS interface supported					
	USB 3.0, USB 2.0, IEEE 1394	a interface				
Hard Drive Controllers	SATA and SAS controllers					
Supported						
Backup Devices	For a complete listing of cor	mpatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup				
	System offerings, please vis	sit http://www.hp.com/go/connect				
Workstation ISV	See the latest list of certific	ations at				
Certifications	http://www.hp.com/united-	-states/campaigns/workstations/partnerships.html				



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Intel Xeon E5-2600 Series - CTO	_			
	Intel® Xeon® Processor E5-2620 6C 2.00GHz	Υ	N		
	Intel® Xeon® Processor E5-2643 4C 3.30GHz	Υ	N		
	Intel Xeon E5-1600 Series				
	Intel® Xeon® Processor E5-1620 4C 3.60GHz	Υ	N		
	Intel® Xeon® Processor E5-1603 4C 2.80GHz	Υ	N		
	Intel Xeon E5-2600 Series - Z620 AMO				
	Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	N	Υ	A6S74AA	
	Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	N	Υ	A6S77AA	
	Intel Xeon E5-2600 v2 Series - CTO				
	Intel® Xeon® Processor E5-2667 v2 8C 3.30GHz	Υ	N		
	Intel® Xeon® Processor E5-2650 v2 8C 2.60GHz	Υ	N		
	Intel® Xeon® Processor E5-2643 v2 6C 3.50GHz	Υ	N		
	Intel® Xeon® Processor E5-2695 v2 12C 2.40GHz	Υ	N		
	Intel® Xeon® Processor E5-2690 v2 10C 3.00GHz	Υ	N		
	Intel® Xeon® Processor E5-2637 v2 4C 3.50GHz	Υ	N		
	Intel® Xeon® Processor E5-2620 v2 6C 2.10GHz	Υ	N		
	Intel® Xeon® Processor E5-2603 v2 4C 1.80GHz	Υ	N		
	Intel® Xeon® Processor E5-2660 v2 10C 2.20GHz	Υ	N		
	Intel® Xeon® Processor E5-2630 v2 6C 2.60GHz	Υ	N		
	Intel® Xeon® Processor E5-2609 v2 4C 2.50GHz	Υ	N		
	Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz	Υ	N		
	Intel® Xeon® Processor E5-2670 v2 10C 2.50GHz	Υ	N		
	Intel® Xeon® Processor E5-2697 v2 12C 2.70GHz	Υ	N		
	Intel® Xeon® Processor E5-2680 v2 10C 2.80GHz	Υ	N		
	Intel Xeon E5-1600 v2 Series				
	Intel® Xeon® Processor E5-1607 v2 4C 3.00GHz	Υ	N		
	Intel® Xeon® Processor E5-1620 v2 4C 3.70GHz	Υ	N		
	Intel® Xeon® Processor E5-1680 v2 8C 3.00GHz	Υ	N		
	Intel® Xeon® Processor E5-1660 v2 6C 3.70GHz	Υ	N		
	Intel® Xeon® Processor E5-1650 v2 6C 3.50GHz	Υ	N		
	Intel Xeon E5-2600 v2 Series - Z620 AMO				
	Z620 Xeon E5-2640 v2 8C 2.00 20MB 1600 CPU2	N	Υ	E3E09AA	
	Z620 Xeon E5-2667 v2 8C 3.30 25MB 1866 CPU2	N	Υ	E3E13AA	
	Z620 Xeon E5-2630 v2 6C 2.60 15MB 1600 CPU2	N	Υ	E3E07AA	
	Z620 Xeon E5-2650 v2 8C 2.60 20MB 1866 CPU2	N	Υ	E3E11AA	
	7620 Vaca EE 2620 :: 2 66 2 10 1 EMD 1600 CDU2	A.I	1/	F3F0C44	



Ν

Υ

E3E06AA

Z620 Xeon E5-2620 v2 6C 2.10 15MB 1600 CPU2

Supported Components

Z620 Xeon E5-2603 v2 4C 1.80 10MB 1333 CPU2	N	Υ	E3E04AA
Z620 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2	N	Υ	E3E16AA
Z620 Xeon E5-2637 v2 4C 3.50 15MB 1866 CPU2	N	Υ	E3E08AA
Z620 Xeon E5-2697 v2 12C 2.70 30MB 1866 CPU2	N	Υ	E3E18AA
Z620 Xeon E5-2609 v2 4C 2.50 10MB 1333 CPU2	N	Υ	E3E05AA
Z620 Xeon E5-2670 v2 10C 2.50 25MB 1866 CPU2	N	Υ	E3E14AA
Z620 Xeon E5-2660 v2 10C 2.20 25MB 1866 CPU2	N	Υ	E3E12AA
Z620 Xeon E5-2695 v2 12C 2.40 30MB 1866 CPU2	N	Υ	E3E17AA
Z620 Xeon E5-2643 v2 6C 3.50 25MB 1866 CPU2	N	Υ	E3E10AA
Z620 Xeon E5-2680 v2 10C 2.80 25MB 1866 CPU2	N	Υ	E3E15AA

NOTE 1: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.

Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Intel's numbering is not a measurement of higher performance.

Z620 processor AMO kits include:

- 2nd CPU/Memory Module (riser)
- processor
- heat sink



Supported Components

SAS Hard Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP SAS (Serial Attached SCSI) Hard Drives for HP Workst	ations			
	HP 300GB SAS 10K SFF HDD	Υ	Υ	A2Z20AA	
	HP 600GB SAS 10K SFF HDD	Υ	Υ	A2Z21AA	
	HP 900GB SAS 10K SFF HDD	Υ	Υ	E2P03AA	
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU967AA	
	450GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU968AA	
	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	VM647AA	
	HP 900GB SAS 10K SFF HDD	Υ	Υ	E2P03AA	
	HP 1.2TB SAS 10K SFF HDD	Υ	Υ	E2P04AA	
	Sub-Section Description/Notes				
	NOTE: SAS Controller add-in card required				
SATA Hard Drives	SATA (Serial ATA) Hard Drives for HP Workstations				
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA	
	500GB SATA 7.2K SED SFF HDD	Υ	Υ	D8N29AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA	
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA	
	3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QF298AA	
	250GB SATA 10K rpm SFF HDD	Υ	Υ	B8X18AA	
	500GB SATA 10K rpm SFF HDD	Υ	Υ	B8X19AA	
	1TB SATA 10K rpm SFF HDD	Υ	Υ	B8X20AA	
SATA Solid State Drives	HP Solid State Drives (SSDs) for Workstations				
	HP 128GB SATA 6Gb/s SSD	Υ	Υ	A3D25AA	
	HP 256GB SATA 6Gb/s SSD	Υ	Υ	A3D26AA	
	HP 256GB SATA 6Gb/s SED SSD	Υ	Υ	D8N28AA	
	HP 512GB SATA 6Gb/s SSD	Υ	N	D8F30AA	
	Seagate 600 Pro 120GB SATA SSD	Υ	Υ	E9Q50AA	
	Seagate 600 Pro 240GB SATA SSD	Υ	Υ	E9Q51AA	
	Seagate 600 Pro 480GB SATA SSD	Υ	Υ	E9Q52AA	
	Intel Pro 1500 180GB SATA SSD	Υ	Υ	F5Z70AA	
	Samsung SM843T 240GB SATA SSD	Υ	Υ	F0W94AA	
PCIe SSDs	PCIe SSDs for HP Workstations				
	Fusion ioFX 410GB PCIe Accelerator	Υ	Υ	E4W49AA	
	For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes.	Actual formatte	d capacity	is less. Up t	to 12 GB of

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

Up to 4 drives are allowed. The 4th drive will occupy one of the external 5.25" bays.



Supported Components

Hard Drive Controllers

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated SATA 6.0 Gb/s Controller				
Integrated SATA 6.0 Gb/s Controller	Υ	N		Two ports
Integrated SATA 3.0 Gb/s Controller				
Integrated SATA 3.0 Gb/s Controller	Υ	N		Eight ports
Factory integrated RAID on motherboard for SATA drives				
RAID 0 Configuration - Striped Array	Υ	N		See note 1
RAID 1 Configuration - Mirrored Array	Υ	N		See note 1
RAID 10 Configuration - Striped/Mirrored Array	Υ	N		See note 1
RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Υ	N		See note 1
LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card				
LSI 9217-4i4e 8-port SAS 6Gb/s RAID Card	Υ	Υ	E0X20AA	
LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card and iBBU	08 Battery Ba	ckup Unit		
LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card	N	Υ	WE465AA	
Optional: LSI iBBU08 Battery Backup Unit for LSI 9260-8i	N	Υ	LA783AA	
LSI 9270-8i SAS 6Gb/s ROC RAID Card	Υ	Υ		
LSI 9270-8i SAS 6Gb/s ROC RAID Card	Υ	Υ	E0X21AA	
DAID amount and the same TD and fully assessment				

RAID arrays greater than 2 TB are fully supported.

NOTE 1: Requires 2 identical hard drives (speeds, capacity, interface). RAID 1 does not support a 3rd HDD. NOTE: Specific user-configured hardware SAS RAID configurations are supported on this system with Linux. For details, please visit: http://www.hp.com/support/linux_hardware_matrix SATA hardware RAID is supported on Linux systems that have support for the Intel RSTe technology. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://www.hp.com/support/linux_hardware_matrix for RAID capabilities with Linux.

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. IS: Striping of 2 or more HDDs into a single logical volume

IM: Mirroring of 2 HDDs into a single logical volume

IME: Mirroring of 3 or more HDDs into a single logical volume

For details, please visit: http://www.hp.com/support/linux_hardware_matrix



Supported Components

Graphics

	Factory		Option Kit Part		Supported		
	Configured O	ption Kit	Number	Support Notes	# of cards	Mixed?	
Professional 2D							
NVIDIA NVS 310 512MB Graphics	Υ	Υ	A7U59AA		4	Yes	
NVIDIA NVS 315 1GB Graphics	Υ	Υ	E1U66AA		4	No	
NVIDIA NVS 510 2GB Graphics	Υ	Υ	C2J98AA	Note 1	2	Yes	

Graphics Cable Adapters

	Factory		Option Kit Part		Suppo	orted
	•	Option Kit	Number	Support Notes	# of cards	Mixed?
HP DisplayPort To DVI-D Adapter (4-Pack)	Υ	N			1	
HP DisplayPort To VGA Adapter 2nd	Υ	N			1	
HP DisplayPort To DVI-D Adapter (6-Pack)	Υ	N			1	
HP DisplayPort To DVI-D Adapter (2-Pack)	Υ	N			1	
HP DisplayPort to Dual Link DVI Adapter	Υ	Υ	NR078AA		1	
HP DisplayPort To VGA Adapter	Υ	Υ	AS615AA		1	
HP DisplayPort To DVI-D Adapter	Y	Υ	FH973AA		1	
Entry 3D						
NVIDIA Quadro 410 512MB Graphics	Υ	Υ	A7U60AA		2	No
NVIDIA Quadro K600 1GB Graphics	Υ	Υ	C2J92AA		2	No
AMD FirePro V3900 1GB Graphics	Υ	Υ	A6R69AA		2	No
Mid-range 3D						
NVIDIA Quadro K2000 2GB Graphics	Υ	Υ	C2J93AA		2	No
High End 3D						
NVIDIA Quadro K4000 3GB Graphics	Υ	Υ	C2J94AA		2	No
NVIDIA Quadro K5000 4GB Graphics	Υ	Υ	C2J95AA		2	No
AMD FirePro W7000 4GB Graphics	Υ	Υ	C2K00AA		2	No
NVIDIA Quadro K6000 12GB Graphics	Υ	Υ	C2J96AA		1	No
OTE 1: If 1st card is NVS 510, 2nd card must be I	NVS 510 or NVS 3	10				

NOTE 1: If 1st card is NVS 510, 2nd card must be NVS 510 or NVS 310.



QuickSpecs

Supported Components

High Performance GPU Computing		Factory	Option	Option Kit Part	Current Notes	
		Configured	Kit	Number	Support Notes	
	NVIDIA Tesla K20c Compute Processor	Υ	Υ	C2J97AA	See note2	
	NVIDIA Tesla K40 Compute Processor	Υ	Υ	F4A88AA	See note 1	

NOTE 1: Tesla K40 is supported with QK5000, QK600 or QK2000.

Not supported with 2 graphics cards.

Not supported with OS WIN32.

Not supported with OS WIN8.0.

NOTE 2: Tesla K20 is supported in combination with NVIDIA Quadro K600/K2000/K4000 1st graphics. Not supported with Win7 32-bit OS.

Memory CT0 **Option Kit Part Support Notes** Number

DDR3-1600 ECC Unbuffered DIMMs - CTO

2GB DDR3-1600 ECC Unbuffered RAM

4GB DDR3-1600 ECC Unbuffered RAM

DDR3-1600 ECC Registered DIMMs - CTO

4GB DDR3-1600 ECC Registered RAM

8GB DDR3-1600 ECC Registered RAM

16GB DDR3-1600 ECC Registered RAM

DDR3-1866 ECC Unbuffered DIMMs - CTO

2GB DDR3-1866 ECC Unbuffered RAM

4GB DDR3-1866 ECC Unbuffered RAM

DDR3-1866 ECC Registered DIMMs - CTO

4GB DDR3-1866 ECC Registered RAM

8GB DDR3-1866 ECC Registered RAM

16GB DDR3-1866 ECC Registered RAM

Sub-Section Description/Notes

The Z620 has a four-channel memory architecture. Four channels are associated with each processor. For optimal performance, populate a DIMM in each channel.

With single-processor configurations, 8 DIMM slots are available. Four additional DIMM slots are available with the 2nd CPU & Memory Module.

AMO

DDR3-1600 ECC Registered DIMMs - AMO

4GB DDR3-1600 ECC Registered RAM	A2Z49AA
8GB DDR3-1600 ECC Registered RAM	A2Z51AA
16GB DDR3-1600 ECC Registered RAM	A2Z52AA

DDR3-1600 ECC Unbuffered DIMMs - AMO

HP 2GB (1x2GB) DDR3-1600 ECC RAM A2Z47AA HP 4GB (1x4GB) DDR3-1600 ECC RAM A2Z48AA

DDR3-1866 ECC Unbuffered DIMMs - AMO



Supported Components

HP 2GB (1x2GB) DDR3-1866 ECC RAM	E2Q90AA
HP 4GB (1x4GB) DDR3-1866 ECC RAM	E2Q91AA
DDR3-1866 ECC Registered DIMMs - AMO	
HP 4GB (1x4GB) DDR3-1866 ECC Reg RAM	E2Q92AA
HP 8GB (1x8GB) DDR3-1866 ECC Reg RAM	E2Q94AA
HP 16GB (1x16GB) DDR3-1866 ECC Reg RAM	E2Q95AA

NOTE: Although all of these memory selections incorporate 1600MHz memory modules, the speed at which they operate is dependent upon the processor.

Multimedia and Audio		Option Kit			
Devices		Factory		Part	Support
		Configured	Option Kit	Number	Notes
	Creative Recon3D PCIe Audio Card	Υ	Υ	BOU68AA	
	Integrated Intel/Realtek HD ALC262 Audio	Υ	N		
	HP Thin USB Powered Speakers	Y	Υ	KK912AA	

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 16X DVD-ROM SATA Drive (non-Lightscribe version)	_	Y	AR629AA	See note 1
	HP 16X DVD+/-RW SuperMulti SATA Drive (non- Lightscribe)	Y	Y	QS208AA	
	HP Blu-ray Writer	Υ	Υ	AR482AA	See note 2
	HP DX115 Removable Drive Enclosure				
	HP DX115 Carrier with 160GB SATA HDD	N	Υ	FZ577AA	
	HP DX115 Removable HDD Frame/Carrier	N	Υ	FZ576AA	
	HP DX115 Removable HDD Carrier	N	Υ	NB792AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd Optical Drive.

NOTE 2: Cannot be ordered in combination with another Blu-ray Writer.



Supported Components

Controller Cards		Option Kit			
		Factory		Part	Support
		Configured	Option Kit	Number	Notes
	HP IEEE 1394b FireWire PCIe Card	Υ	Υ	NK653AA	
	HP Thunderbolt-2 PCIe 1-port I/O Card	Υ	Υ	F3F43AA	

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel 82579LM PCIe GbE Controller	Υ	N		See note 2
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Υ	Υ	FS215AA	See notes 1 and 2
	Intel Gigabit CT Desktop NIC	N	Υ	FH969AA	See note 2
	HP X520 10GbE Dual Port Adapter	Υ	Υ	C3N52AA	See note 2
	HP 10GbE SFP+ SR Transceiver	Υ	Υ	C3N53AA	See note 2
	HP 361T PCIe Dual Port Gigabit NIC	N	Υ	C3N37AA	See note 2
	Intel Ethernet I210-T1 PCIe NIC	Υ	Υ	E0X95AA	See note 2

NOTE 1: This is a PCI Express card based on the Broadcom 5761 chip. This card does not support DASH 1.1 manageability on this platform.

NOTE 2: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical		Option Kit				
Security		Factory Configured	Option Kit	Part Number	Support Notes	
	Security Cable with Kensington Lock	N	Υ	PC766A		
	HP (CMT) Solenoid Lock	N	Υ	DE618A		
	HP Solenoid Hood Lock & Hood Sensor	Υ	N			
	HP Z6/8 Adjustable Rail Rack Kit, Flush Mount	N	Υ	B8S55AA		

Supported Components

Input Devices		Factory		Option Kit Part	
		Configured	Option Kit		Support Notes
	HP PS/2 Keyboard	Υ	Υ	QY774AA	
	HP PS/2 Mouse	Υ	Υ	QY775AA	
	HP USB Keyboard	Υ	Υ	QY776AA	
	HP USB Optical Mouse	Υ	Υ	QY777AA	
	HP USB 1000dpi Laser Mouse	Υ	Υ	QY778AA	
	HP Wireless Keyboard and Mouse	N	Υ	QY449AA	
	HP USB Smart Card Keyboard	N	Υ	E6D77AA	
	HP USB Optical 3-Button 2.9M OEM Mouse	N	Υ	ET424AA	
	HP SpaceMouse Pro USB 3D Input Device	N	Υ	B4A20AA	
	HP SpacePilot Pro 3D USB Intelligent Controller	N	Υ	WH343AA	
	Product numbers QY774AA-QY778AA represent the The previous models will be phased out over time.	new 2012 produ	cts with the	e updated p	roduct design.

Other Hardware				Option Kit	
		Factory		Part	
		Configured (Option Kit	Number	Support Notes
	HP Workstation Mouse Pad	Υ	N		Japan only.
	HP Power Cord Kit	N	Υ	DM293A	
	HP eSATA PCI Cable Kit	N	Υ	GM110AA	
	HP Serial Port Adapter	N	Υ	PA716A	
	HP Internal USB Port Kit	N	Υ	EM165AA	Note 1
	HP Optical Bay HDD Mounting Bracket	Υ	Υ	NQ099AA	For 3.5" HDDs
	HP Energy Star Enabled Configuration	Υ	N		
	Note 1: The HP Internal USB Port kit has a single USB	2.0 type A conne	ector.		



Supported Components

Software

		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP	Performance Advisor	Υ	Υ		See note 1
HP	Remote Graphics Software (RGS) 6.0	Υ	N		See note 2
HP	ProtectTools Security	Υ	N		See note 3
HP	Power Assistant	Υ	N		Win7 only
PDI	Complete - Trial Edition	Υ	N		
Cyt	erlink Media Suite & PowerDVD	Υ	N		Media playback and authoring software
MS	Office Home & Business 2013	Υ	N		See note 3

NOTE 1: Available as a free download here: www.hp.com/go/performanceadvisor

NOTE 2: Supports both 32 and 64 bit versions of Windows 7 Professional and Enterprise, Windows XP Professional and Enterprise, and RHEL V6

NOTE 3: Must select as a Configure to Order option. Delivered as a "Drop in the Box" CD. Not Supported with Windows 7 Ultimate. Not Supported with Linux.

Operating	Systems	
operating	Jysteilis	

Support Notes

Genuine Windows® 7 Ultimate 64-bit See note 1 See note 1

Genuine Windows® 7 Professional

64-bit

Genuine Windows® 7 Professional See note 1

32-bit

HP Linux Installer Kit

Red Hat Enterprise Linux (RHEL) See note 2

Workstation - Paper License (1yr)

Windows 8 Pro 64-bit

Windows 8 Simplified Chinese

Edition 64-bit

Windows 8 Pro Downgrade to

Windows 7 Professional 32-bit

Windows 8 Pro Downgrade to

Windows 7 Professional 64-bit

Windows 8.1 Pro 64-bit

Windows 8.1 Simplified Chinese

Edition 64-bit

Windows 8.1 Pro Downgrade to

Windows 7 Professional 64-bit

Windows 8.1 Pro Downgrade to

Windows 7 Professional 64-bit

(National Academic)

Windows 8.1 Pro Downgrade to

Windows 7 Professional 32-bit



Supported Components

Windows 8.1 Pro Downgrade to Windows 7 Professional 32-bit (National Academic)

NOTE 1: See http://www.microsoft.com/windows/windows-7/ for support details. **NOTE 2:** This second OS must be ordered with the HP Linux Intaller Kit as the first OS.



System Board	
System Board Form Factor	Main System Board: 24 x 31 cm 9.6 x 12.2 inches 2nd CPU/Memory Board (optional): 14.9 x 29.2 cm 5.85 x 11.50 inches
Processor Socket	LGA2011 1st CPU on system board 2nd CPU on optional 2nd CPU/Memory Module
CPU Bus Speed	QPI: Up to 8.0GT/second, depending on processor
Chipset	Intel C602 Chipset
Super I/O Controller	Nuvoton NPCD379H (SIO-12)
Memory Expansion Slots	8 on system board(CPU0) + 4 on optional 2nd CPU/Memory Module (CPU1)
Memory Type Supported	DDR3, UDIMM (Unbuffered), ECC: 2GB and 4GB DDR3, RDIMM (Registered), ECC: 4GB, 8GB, and 16GB
Memory Modes	NUMA (Non-Uniform Memory Architecture), Memory Node Interleave
Memory Speed Supported	1066, 1333, & 1600MHz



¤	¤				Single·P	rocesso	r¤		
¤	¤			U0⊷ •Slots¤		, , , , , , , , , , , , , , , , , , , ,	March .	U0⊷ ·Slots¤	
Capacity⊷ (GB)¤	Type [□]	J¤.	DIMM∙ 2 [™]	3¤	DIMM·	DIMM· 5¤	6 α	DIMM∙ 7 [□]	8¤ DIWW∙
4¤	UDIMM¤	4GB¤	٥¤	°¤	ο¤	°¤	٥¤	ď	°¤
8¤	UDIMM¤	4GB¤	°¤	°¤	°¤	°¤	°¤	°¤	4GB¤
12¤	UDIMM¤	4GB¤	°¤	4GB¤	°¤	°¤	°¤	°¤	4GB¤
16¤	UDIMM¤	4GB¤	°¤	4GB¤	°¤	°¤	4GB¤	°¤	4GB¤
24¤	UDIMM¤	4GB¤	4GB¤	4GB¤	°¤	٥¤	4GB¤	4GB¤	4GB¤
32¤	UDIMM¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤
32¤	UDIMM¤	8GB¤	°¤	8GB¤	۵°	°¤	8GB¤	°¤	8GB¤
32¤	RDIMM¤	8GB¤	۵¤	8GB¤	°¤	°¤	8GB¤	°¤	8GB¤
48¤	UDIMM¤	8GB¤	4GB¤	8GB¤	4GB¤	4GB¤	8GB¤	4GB¤	8GB¤
64¤	UDIMM¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
64¤	RDIMM¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
64¤	RDIMM¤	16GB¤	°¤	16GB¤	°¤	°¤	16GB¤	°¤	16GB¤
96¤	RDIMM¤	16GB¤	8GB¤	16GB¤	8GB¤	8GB¤	16GB¤	8GB¤	16GB¤
128¤	RDIMM¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤
Slot-Load	·Order¤	η¤	5¤	3¤	7¤	8¤	4¤	6¤	2¤



System Technical Specifications

n	п	Dual·Processor [™]											
а	¤			U0⊷ •Slots¤				U0⊷ Slots¤		117.00	U1⊷ ·Slots¤		U1⊷ ·Slots¤
Capacity↔ (GB) [©]	Type [□]	DIMM-	DIMM- 2 ^{II}	3¤	DIMM- 4 ^{II}	DIMM- 5 [©]	DIWM∙	DIMM∙ 7 [□]	8¤	DIMM-	DIMM- 2 ^{II}	JiMM∙	DIMM- 4 [©]
8¤	UDIMM¤	4GB¤	٥¤	٥Þ	٥¤	°¤	°p	op	ο¤	4GB¤	٥¤	ο¤	οĦ
16¤	UDIMM¤	4GB¤	٥¤	°¤	°¤	°¤	°¤	°¤	4GB¤	4GB¤	٥¤	°¤	4GB¤
24¤	UDIMM¤	4GB¤	ο¤	4GB¤	°ZI	°P	°PI	°p	4GB¤	4GB¤	4GB¤	°P	4GB¤
32¤	UDIMM¤	4GB¤	٥¤	4GB¤	٥¤	°¤	4GB¤	°¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤
40¤	UDIMM¤	4GB¤	4GB¤	4GB¤	°¤	°¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤
48¤	UDIMM¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤	4GB¤
64¤	UDIMM¤	8GB¤	°¤	8GB¤	°¤	°¤	8GB¤	°E	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
64¤	RDIMM¤	8GB¤	°72	8GB¤	°¤	°¤	8GB¤	°p	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
96¤	UDIMM¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤	8GB¤
96¤	RDIMM¤	16GB¤	°¤	8GB¤	°¤	°¤	8GB¤	°¤	16GB¤	16GB¤	8GB¤	8GB¤	16GB¤
128¤	RDIMM¤	16GB¤	°¤	16GB¤	°¤	°¤	16GB¤	°¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤
160¤	RDIMM¤	16GB¤	8GB¤	16GB¤	8GB¤	8GB¤	16GB¤	8GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤
192¤	RDIMM¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤	16GB¤
Slot-Load	·Order¤	Į¤	9¤	5¤	11¤	12¤	7¤	10¤	3¤	2¤	6¤	8¤	4¤

NOTE: CPU0 is located on the main system board. CPU1 (optional) is located on an add-in riser card.

Maximum Memory	Supports up to 192GB with two processors and (12) 16 GB DIMMs
Memory Configuration (Supported)	 Not all memory configurations possible are represented above. Only ECC DIMMs are supported. Do not install memory modules into memory slots if corresponding processor is not installed. Dual processor configurations with memory modules installed for only one processor is not supported. UDIMM (Unbuffered) and RDIMM (Registered) memory cannot be mixed. All memory installed in the system must be either UDIMM or RDIMM.
PCI Express Connectors	Slot 1 (top): PCI Express Gen2 x4(1)* Full-height, Half-length (not available when 2nd CPU/Memory Module is installed) Slot 2: PCI Express Gen3 x16 Full-height, Full-length (with extender) Slot 3: PCI Express Gen2 x8(4)* with open-ended connector** Full-height, Full-length (with extender) Slot 4: PCI Express Gen3 x8 with open-ended connector**

PCI 32bit/33MHz Full-height, Full-length (with extender) SATA Integrated 10-channel SATA interface (2@6Gb/s, 8@3Gb/s). Supports RAID 0, 1, 5, 10 and NCQ. Factory integrated RAID is Microsoft Windows only. Serial Attached SCSI Requires Optional PCIe card Integrated RAID Integrated SATA RAID RAID 0, RAID 1*, RAID 5, RAID 10 RAID 0, RAID 1*, RAID 5, RAID 10 RAID 10 configuration - striped array (supported and configure to order) RAID 1 configuration - striped array (supported and configure to order) RAID 1 configuration - mirrored array (supported and configure to order) RAID 10 striped and mirrored array "HW RAID functionality not supported but not configure to order) RAID 10 striped and mirrored array "HW RAID functionality not supported by Linux. Use SW RAID functionality provided in the Red Hat Operating system instead. Integrated Graphics No Network Controller Integrated AKB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCIe 1.0a Data path width X1 Data path speed 2.5Gbit per sec per direction transfer rate Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 10BASE-T (full-duplex) 200 Mb/s 100BASE-T (full-duplex) 200 Mb/s Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professional 32 and 644 Management capabilities AMT/vPro Technology	System Technical Specific	ations						
PCI Express Gen 3 x 16 Full-height, Full-length (with extender) *x-number> = number of lanes or size of the physical/mechanical connector. (number) = number of lanes supported electrically. Typically communicated as x# mechanical, x(#)electrical. ** Open-ended connector allow a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot. Solot 6: PCI 32bit/33MHz Full-height, Full-length (with extender) Supported Drive Interfaces SATA Integrated 10-channel SATA interface (2@66b/s, 8@36b/s). Supports RAID 0, 1, 5, 10 and NCQ. Factory integrated RAID is Microsoft Windows only. Serial Attached SCSI Requires Optional PCIe card		Full-height, Full-length (with extend	ler)					
(number) = number of lanes supported electrically. Typically communicated as x# mechanical, x(#) electrical. x(#) electrica		PCI Express Gen3 x16						
PCI 32bit/33MHz Full-height, Full-length (with extender) SATA Integrated 10-channel SATA interface (2@6Gb/s, 8@3Gb/s). Supports RAID 0, 1, 5, 10 and NCQ. Factory integrated RAID is Microsoft Windows only. Serial Attached SCSI Requires Optional PCIe card Integrated RAID Integrated SATA RAID RAID 0, RAID 1*, RAID 5, RAID 10 Supports one RAID array with 2-4 drives RAID 0 configuration - striped array (supported and configure to order) RAID 1 configuration - striped array (supported and configure to order) RAID 1 configuration - mirrored array (supported and configure to order) RAID 10 striped and mirrored array "HW RAID functionality not supported but not configure to order) RAID 10 striped and mirrored array "HW RAID functionality not supported by Linux. Use SW RAID functionality provided in the Red Hat Operating system instead. Integrated Graphics No Network Controller Integrated 4BKB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCIe 1.0a Data path width X1 Data ransfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3 V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 10BASE-T (full-duplex) 200 Mb/s 100BASE-T (full-duplex) 200 Mb/s 100BASE-T (full-duplex) 200 Mb/s Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professional 32 and 64, Management capabilities AMT/vPro Technology		 (number) = number of lanes supported electrically. Typically communicated as x# mechanical, x(#)electrical. ** open-ended connector allow a greater bandwidth (e.g. x16) card to be installed physically in 						
Serial Attached SCSI Requires Optional PCIe card	PCI Connectors (5.0V)	PCI 32bit/33MHz	ler)					
Integrated RAID • Integrated SATA RAID • RAID 0, RAID 1*, RAID 5, RAID 10 • Supports one RAID array with 2-4 drives • RAID 0 configuration - striped array (supported and configure to order) • RAID 1 configuration - mirrored array (supported and configure to order) • RAID 5 parity striping (supported but not configure to order) • RAID 10 striped and mirrored array *HW RAID functionality not supported by Linux. Use SW RAID functionality provided in the Red Hat Operating system instead. No Integrated Graphics No • Integrated Intel 82579 and 82574 Controllers. • Memory Integrated 48KB receive buffer and 8KB transmit buffer • Data rates supported 10/100/1000 Mb/s • Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control • Bus architecture PCIe 1.0a • Data path width X1 • Data path speed 2.5Gbit per sec per direction transfer rate • Data transfer mode Bus-master DMA • Power requirement 1.0 watts @ +3.3V AUX supply • Boot ROM support Yes • Network transfer rate 10BASE-T (half-duplex) 10 Mb/s • 100BASE-TX (half-duplex) 20 Mb/s • 100BASE-TX (full-duplex) 200 Mb/s • 100BASE-TX (full-duplex) 200 Mb/s • 100BASE-TX (full-duplex) 200 Mb/s • Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professional 32 and 64 • Management capabilities AMT/vPro Technology	Supported Drive Interfaces	SATA	8@3Gb/s). Supports RAID 0, 1, 5, 10 and NCQ. Factory					
RAID 0, RAID 1*, RAID 5, RAID 10 Supports one RAID array with 2-4 drives RAID 0 configuration - striped array (supported and configure to order) RAID 1 configuration - mirrored array (supported and configure to order) RAID 5 parity striping (supported but not configure to order) RAID 10 striped and mirrored array *HW RAID functionality not supported by Linux. Use SW RAID functionality provided in the Red Hat Operating system instead. No Integrated Graphics No Integrated Intel 82579 and 82574 Controllers. Memory Integrated 48KB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCle 1.0a Data path width XI Data path speed 2.5Gbit per sec per direction transfer rate Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mb/s 10BASE-T3 (full-duplex) 20 Mb/s 100BASE-T3 (full-duplex) 2000 Mb/s 100BASE-T3 (full-duplex) 2000 Mb/s Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professional 32 and 64 Management capabilities AMT/vPro Technology		Serial Attached SCSI	Requires Optional PCIe card					
 Integrated Intel 82579 and 82574 Controllers. Memory Integrated 48KB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCle 1.0a Data path width X1 Data path speed 2.5Gbit per sec per direction transfer rate Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 100BASE-TX (full-duplex) 2000 Mb/s Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professional 32 and 64 Management capabilities AMT/vPro Technology 	integrated KAID	 RAID 0, RAID 1*, RAID 5, RAID 10 Supports one RAID array with 2-4 drives RAID 0 configuration - striped array (supported and configure to order) RAID 1 configuration - mirrored array (supported and configure to order) RAID 5 parity striping (supported but not configure to order) RAID 10 striped and mirrored array *HW RAID functionality not supported by Linux. Use SW RAID functionality provided in the						
 Memory Integrated 48KB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mb/s Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCle 1.0a Data path width X1 Data path speed 2.5Gbit per sec per direction transfer rate Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professional 32 and 64 Management capabilities AMT/vPro Technology 	Integrated Graphics	No						
SATA Connectors 10 ports/connectors (6 ports may be cabled to optional eSATA cable kits [2 ports per cable kit])	Network Controller	 Memory Integrated 48KB rece Data rates supported 10/100 Compliance IEEE 802.3, 802.3 Bus architecture PCIe 1.0a Data path width X1 Data path speed 2.5Gbit per se Data transfer mode Bus-mas Power requirement 1.0 watts Boot ROM support Yes Network transfer rate 10BASI 10BASE-T (full-duplex) 20 Mb 100BASE-TX (half-duplex) 10 100BASE-TX (full-duplex) 20 Microsoft Windows Vista Busi 64 Management capabilities AM 	eive buffer and 8KB transmit buffer /1000 Mb/s /AB and 802.3u compliant, 802.3x flow control ec per direction transfer rate ter DMA @ +3.3V AUX supply E-T (half-duplex) 10 Mb/s //s 0 Mb/s 0 Mb/s 0 Mb/s ness 32 and 64, Microsoft Windows XP Professional 32 and					
po. to, to mile the may be cauted to optional continued to per table mile	SATA Connectors	10 ports/connectors (6 ports may be	e cabled to optional eSATA cable kits [2 ports per cable kit])					



IEEE 1394a or 1394b	1394a is integrated 1394b is optional with PCIe card Cable from Front IO can be plugg Not supported in Linux	ed into PCIe Card.		
IEEE 1394 Connector(s)	Front	1 - 1394a		
	Rear	1 - 1394a		
	Internal	No		
USB Connector(s)	Front	1 - USB 2.0 2 - USB 3.0		
	Rear	4 - USB 2.0 2 - USB 3.0		
	Internal 6 USB 2.0 ports available with three separate 2 headers. Each header supports either a HP Internal Port Kit (EM165AA) or USB Media Card reader. Each Internal Port Kit has one (1) USB 2.0 connormal Third-Party adaptors are available to convert theaders to two USB 2.0 connectors. For these the adaptor should include a minimum of 8 incomplete adaptor should include a minimum of 8 incomplete adaptor to insure sufficient cable-routing 2.0 connector to insure sufficient cable-routing the support of the sup			
HD Integrated Audio	Realtek ALC262			
Flash ROM	Yes			
CPU Fan Header	One for each CPU socket			
Chassis Fan Header	Rear System Chassis Fan Header Front System Chassis Fan Heade	r		
CMOS Battery Holder – Lithium	Yes			
Integrated Trusted Platform Module	TPM 1.2, Infineon			
Power Supply Headers	Yes			
Power Switch, Power LED & Hard Drive LED Header	Yes (includes speaker and intrusi	on sensor signals)		
Clear Password Jumper	Yes			
Serial Port	Optional			
Parallel Port	No			
Keyboard/Mouse	PS/2			



Z620 Required Power Supply Info						
Power Supply		800W 90% Efficie	ent. Custom PSU			
- Carpey		800W 90% Efficient, Custom PSU (Wide Ranging, Active PFC)				
Operating Voltage Range		90–26	9 VAC			
Rated Voltage Range		100-240 V 118 V				
Rated Line Frequency		50–60 Hz 400 Hz				
Operating Line Frequency Range		47–66 Hz 393–407 Hz				
Rated Input Current		9.7 A @ 100-240 V	9.7 A @ 400 V			
Heat Dissipation		Typical = 1972 btu/hr (497 kcal/hr)				
(Configuration and software depend	lent)	Maximum = 3139 b	tu/hr (791 kcal/hr)			
Power Supply Fan		92x25 mm va	ariable speed			
ENERGY STAR Qualified		Ye	25			
(Configuration dependent)						
80 PLUS® Compliant		Yes, 90%	Efficient			
		The Z620 800W power supply efficienc	•			
FEMP Standby Power Compliant @1 (<2W in S5 - Power Off)	15V	Ye	25			
EuP Compliant @ 230V (<0.5 W in S5 - Power Off)			25			
CECP Compliant @ 220V (<4W in S3 - Suspend to RAM)		Yes; Configuration dependent				
Power Consumption in sleep mode (as defined by ENERGY STAR) - Suspe (Instantly Available PC)	nd to RAM (S3)	<1!	5W			
Built-in Selft Test LED		Ye	25			
Surge Tolerant Full Ranging Power ((withstands power surges up to 200		Υe	25			
Access Panel Solenoid Lock Header	Yes					
Access Panel Intrusion Sensor Header	Yes	t User Interface (Power Switch, Power Li	ED, HDD LED, Speaker) Cable			
Multibay Header	No					
Integrated Gigabit Ethernet	Integrated Intel 82	2579 and 82574 Controllers				
Wake on LAN	Yes					
ASF 1.0/2.0 (Alert Standard Format)	No					
TPM	Integrated TPM 1.2; Infineon					
Password Clear Header	Yes					
AUX IN (audio)	No					
Clear CMOS Button	Yes					



System Technical Specifications

System Configuration

Example Configuration #1	Processor Info	1x Intel Xeon	E5-2650 (Eid	nht-Core)					
(ENERGY STAR QUALIFIED)		4x 2GB DDR3 1600 (UDIMM)							
,,	Graphics Info	1x NVIDIA Qu	=	•					
	Disks/Optical/Floppy			6X DVD-ROM	SATA				
	Power Supply	800W 90% C	ustom PSU						
	Other	1x NVIDIA Te	sla C2075						
Energy Consumption		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	111	1 W	110	D W	11	1 W		
	Windows Busy Typ (S0)	287 W 276 W 286 W					5 W		
	Windows Busy Max (S0)	396 W		390 W		398 W			
	Sleep (S3)	4.25 W	4.10 W	4.43 W	4.31 W	4.25 W	4.11 W		
	Off (S5)	1.81 W	1.62 W	2.07 W	1.89 W	1.79 W	1.61 W		
	Zero Power Mode (ErP)	0.2	5 W	0.4	5 W	0.2	3 W		
Heat Dissipation**		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	379 b	tu/hr	375 btu/hr		379 b	tu/hr		
	Windows Busy Typ (S0)	979 btu/hr		942 b	tu/hr	976 b	tu/hr		
	Windows Busy Max (S0)	1351 btu/hr		1331	btu/hr	1358 btu/hr			
	Sleep (S3)	14.5 btu/hr 14.0 btu/hr		15.1 btu/hr	14.7 btu/hr	14.5 btu/hr	14.0 btu/hr		
	Off (S5)	6.18 btu/hr	5.53 btu/hr	7.06 btu/hr	6.45 btu/hr	6.11 btu/hr	5.49 btu/hr		
	Zero Power Mode (ErP)	0.85 l	btu/hr	1.54 l	otu/hr	0.781	otu/hr		

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Example Configuration #2	1	1x Intel Xeon E5-2643 (Four-Core)							
(ENERGY STAR QUALIFIED)	Memory Info	4x 4GB DDR3 1600 (UDIMM)							
	Graphics Info	1x NVIDIA NV	'S 300						
	Disks/Optical/Floppy	2x 500GB SA	TA 7200/1x 1	6X DVD-ROM	SATA				
	Power Supply	800W 90% Ci	ustom PSU						
	Other	-							
Energy Consumption		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	66.	8 W	66.	3 W	66.	9 W		
	Windows Busy Typ (S0)	170 W 169 W 171 W					1 W		
	Windows Busy Max (S0)	193	3 W	190 W		193 W			
	Sleep (S3)	4.43 W	4.31 W	4.62 W	4.51 W	4.43 W	4.33 W		
	Off (S5)	1.81 W	1.38 W	2.07 W	1.64 W	1.78 W	1.36 W		
	Zero Power Mode (ErP)	0.2	4 W	0.4	5 W	0.2	3 W		
Heat Dissipation**		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	228 b	tu/hr	226 b	tu/hr	228 b	tu/hr		
	Windows Busy Typ (S0)	580 btu/hr		577 t	tu/hr	583 b	tu/hr		
	Windows Busy Max (S0)	659 btu/hr 648 btu/hr				659 btu/hr			
	Sleep (S3)	15.1 btu/hr	14.7 btu/hr	15.8 btu/hr	15.4 btu/hr	15.1 btu/hr	14.8 btu/hr		
	Off (S5)	6.18 btu/hr	4.71 btu/hr	7.06 btu/hr	5.60 btu/hr	6.07 btu/hr	4.64 btu/hr		



Zero Power Mode (ErP)	0.82 btu/hr	1.54 btu/hr	0.78 btu/hr
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Example Configuration #3			ı E5-2690 (Eig	•					
(ENERGY STAR QUALIFIED)	,	8x 8GB DDR3 1600 (RDIMM)							
	Graphics Info	1x NVIDIA Qu	ıadro 2000						
	Disks/Optical/Floppy	2x 250GB SA	TA 7200/1x 1	6X DVD+-RW	SuperMulti S	ATA			
	Power Supply	800W 90% C	ustom PSU						
	Other	-							
Energy Consumption		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	12	1 W	12	D W	127	2 W		
	Windows Busy Typ (S0)	506 W 494 W 518 W							
	Windows Busy Max (S0)	54 ⁻	1 W	531 W		544 W			
	Sleep (S3)	7.75 W	7.57 W	7.84 W	7.67 W	7.82 W	7.62 W		
	Off (S5)	1.97 W	1.57 W	2.18 W	1.82 W	1.96 W	1.55 W		
	Zero Power Mode (ErP)	0.2	4 W	0.4	4 W	0.2	3 W		
Heat Dissipation**		115	VAC	230	VAC	100	VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	413 t	otu/hr	409 t	tu/hr	416 b	tu/hr		
	Windows Busy Typ (S0)	1727	btu/hr	1686	btu/hr	1767	btu/hr		
	Windows Busy Max (S0)	1846 btu/hr		1812	btu/hr	1856	btu/hr		
	Sleep (S3)	26.4 btu/hr	25.8 btu/hr	26.8 btu/hr	26.2 btu/hr	26.7 btu/hr	26.0 btu/hr		
	Off (S5)	6.72 btu/hr	5.36 btu/hr	7.44 btu/hr	6.21 btu/hr	6.69 btu/hr	5.29 btu/hr		
	Zero Power Mode (ErP)	0.82	btu/hr	1.50	otu/hr	0.78 l	otu/hr		

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Example Configuration #4	Processor Info	2x Intel Xeon E5-2620 (Six-Core)					
	Memory Info	12x 4GB DDR	3 1600 (UDIM	1M)			
	Graphics Info	2x NVIDIA Qu	ıadro 5000				
	Disks/Optical/Floppy	4x 600GB SA	S 15K/1x 16X	DVD+-RW Su	perMulti SAT	Α	
	Power Supply	800W 90% C	ustom PSU				
	Other	LSI 9212 SAS	Card				
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	216	5 W	21:	3 W	217	7 W
	Windows Busy Typ (S0)	52!	5 W	48!	5 W	512	2 W
	Windows Busy Max (S0)	644	4 W	63 ⁻	1 W	647	7 W
	Sleep (S3)	9.27 W	8.81 W	9.36 W	8.91 W	9.31 W	8.89 W
	Off (S5)	1.85 W	1.43 W	2.12 W	1.68 W	1.83 W	1.41 W
	Zero Power Mode (ErP)	0.2	5 W	0.4	5 W	0.2	3 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	737 b	tu/hr	727 b	tu/hr	740 b	tu/hr
	Windows Busy Typ (S0)	1791	btu/hr	1655	btu/hr	1747	btu/hr
	Windows Busy Max (S0)	2197	btu/hr	2153	btu/hr	2208	btu/hr
	Sleep (S3)	31.6 btu/hr	30.1 btu/hr	31.9 btu/hr	30.4 btu/hr	31.8 btu/hr	30.3 btu/hr
	Off (S5)	6.31 btu/hr	4.88 btu/hr	7.23 btu/hr	5.73 btu/hr	6.24 btu/hr	4.81 btu/hr



	Zero Power Mode (ErP)	0.85 btu/hr	1.54 btu/hr	0.78 btu/hr

Declared Noise Emissions (Entry-level and High-end configurations)		
System Configuration (Entry level)	Processor Info	Single Intel Xeon E5-2640 2.50 GHz
	Memory Info	4 - 2 GB DDR3 1333 MHz UDIMM
	Graphics Info	NVIDIA Q400
	Disks/Optical/Floppy	Single 1 TB 7200 RPM SATA

		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.3	16
	Hard drive Operating (random reads)	3.9	22
	DVD-ROM Operating (sequential reads)	5.1	39

System Configuration	Processor Info	Dual Xeon E5-2690 2.90 GHz
(High-end)	Memory Info	12 - 4GB DDR3 1600 MHz UDIMM
	Graphics Info	NVIDIA Q4000
	Disks/Optical/Floppy	Dual 600 GB 15K RPM SAS 3.5" DVD ROM

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	4.4	29
	Hard drive Operating (random reads)	4.8	32
1	DVD-ROM Operating (sequential reads)	5.1	36



Environmental Requirements	Temperature	Operating: 5°C to 35°C (40°F to 95°F) Non-operating: -40°C to 60°C (-40°F to 140°F)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 3,048 m (10,000 ft) Non-operating: 9,144 m (30,000 ft)
	Dynamic (new)	Shock Operating: ½-sine: 40 g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105 g) square: 20 g, 422 cm/s NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5 g (rms), 5-300 Hz, up to 0.0025 g²/Hz Non-operating random: 2.0 g (rms), 5-500 Hz, up to 0.0150 g²/Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 1524m (5,000 ft) altitude, maximum operating temperature is de-rated by 1°C (1.8°F) per 305m (1,000 ft) elevation increase

Physical Security a	nd Serviceability	
Access Panel	Tool-less Includes system board and memory information	
Optical Drive	Tool-less, no carrier or rails required	
Hard Drives	Tool-less	
	Integrated blind-mate drive carriers	
	Optional 5.25" external bay carriers	
Expansion Cards	Tool-less	
Processor Socket	1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module.	
Green User Touch Points	Yes, on primary serviceable components	
Color-coordinated Cables and Connectors	Yes	
Memory	Tool-less	
System Board	Tool-less 2nd CPU/Memory Module: Tool-less	
Dual Color Power and HD LED on Front of Computer	Yes	
Configuration Record SW	Yes	
Over-Temp Warning on Screen	Yes, at POST screen on reboot.	
Restore CD/DVD Set	Yes, restores the computer to its original factory shipping image - Can be obtained via HP Support.	



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Dual Function Front Power Switch	Yes, also acts as a reset switch when held for 4 seconds.		
Padlock Support	No		
Cable Lock Support	Yes, Kensington Cable Lock (optional): Prevents entire system theft only. 3mm x 7mm slot at rear of system		
Universal Chassis Clamp Lock Support	No		
Solenoid Lock and Hood Sensor	Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry. Access Panel Intrusion Sensor: Yes (optional).		
Rear Port Control Cover	No		
Removable Media Write/Boot Control	Yes, user can prevent the workstation from writing to or booting from removable media.		
Power-On Password	Yes, prevents an unauthorized person from booting up the computer.		
Setup Password	Yes, prevents an unauthorized person from changing the system configuration.		
3.3V Aux Power LED on System PCA	No		
NIC LEDs (integrated) (Green & Amber)	Yes		
CPUs and Heatsinks	CPU heatsink removal requires a T-15 Torx or flat blade screwdriver. CPU removal is tool-less.		
Power Supply Diagnostic LED	Yes		
Front Power Button	Yes		
Rear Power Button	Yes		
Front Power LED	Yes, blue (normal), red (fault)		
Front Hard Drive Activity LED	Yes, green		
Front ODD Activity LED	Yes		
Internal Speaker	Yes		
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS		
Cooling Solutions	Air cooled forced convection		
Power Supply Fans	1 - 92mm		
CPU Heatsink Fan	1st CPU: 1 - 92mm Optional 2nd CPU: 1 - 92mm		
Memory Heatsink Fan	System Board Memory: rear bank: 1 - 60mm, front bank: 1 - 40mm Optional 2nd CPU/Memory Module: rear bank: 1 - 80mm.		
HP Vision Diagnostics Offline Edition	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to: • Run diagnostics		
	View the hardware configuration of the system		



cincations
Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision diagnostics helps provide higher system availability. Typical uses of the Vision Diagnostics are: • Testing and diagnosing apparent hardware failures • Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance • Sending configuration information to another location for more in-depth analysis Yes, prevents removal of the access panel and all internal components including devices installed in the
external 5.25" bays.
 Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system
Yes, Infineon SLB9635TT1.2
Yes
Tool-less. Includes integrated handle.
Yes, tool-less Rear (all) Middle (full-height cards) Front (full-length cards with extender)
SPI ROM
Yes
Yes - Not supported on Linux

BIOS		
BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4	
PCI 3.0 Support	ull BIOS support for PCI Express through industry standard interfaces	
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0	



nnc	PLOS Deat Consideration of 04		
BBS	BIOS Boot Specification v1.01		
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.		
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot		
BIOS Power On	Users can define a specific date and time for the system to power on		
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS		
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM		
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).		
SMBIOS	System Management BIOS 2.7 for system management information		
Boot Control	Disables the ability to boot from removable media on supported devices		
Memory Change Alert	Alerts management console if memory is removed or changed		
Thermal Alert	 Monitors the temperature state within the chassis. Three modes: NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs. 		
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console		
ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.		
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen		
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location		
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time		
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system		
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.		
System board revision level	Allows management SW to read revision level of the system board Revision level is digitally encoded into the HW and cannot be modified		



System Technical Specifications

Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing		
Auto Setup when new hardware installed	System automatically detects the addition of new hardware		
Keyboard-less Operation	The system can be booted without a keyboard		
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings		
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memor		
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually		
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics		
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED		
Industry Standard Specification Support			
UEFI Specification Revision	2.3.1		
Industry Standard	Revision Supported by the BIOS		
ACPI	Advanced Configuration and Power Management Interface, Version 2.0		
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b		
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0		
EDD	 Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0 		
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0		
PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft 0.7 		
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0		
PMM	POST Memory Manager Specification, Version 1.01		
SATA	 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 		
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2		
TPM	Trusted Computing Group TPM Specification Version 1.2		
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1		
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.0 Specification		
SMBIOS	System Management BIOS Reference Specification, Version 2.7		

Social and Environmental Responsibility



System Technical Spe			
Eco-Label Certifications & Declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:		
	 ENERGY STAR® (energy-saving features available on selected configurations-Windows only) US Federal Energy Management Program (FEMP) 		
	 China Energy Conservation Program IT ECO declaration 		
Batteries	The battery in this product complies with EU Directive 2006/66/EC		
	Battery size: CR2032 (coin cell)		
	Battery type: Lithium Metal		
	The battery in this product does not contain:		
	Mercury greater than 5ppm by weight		
	Cadmium greater than 10ppm by weight		
	Lead greater than 40ppm by weight		
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the Environment.		
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf		
	Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations,		
	including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed		
Low Halogen Statement	compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. This product is low halogen except for power cords, cables and peripherals, as well as the following		
Low natogen Statement	customer-configurable internal components: 3 ½" SAS HDDs, LSI 9260-8i SAS 6Gb/s ROC RAID Card,		
	Creative Recon3D PCIe Audio Card, Liquid Cooling Solution and Broadcom 5761 Gigabit PCIe NIC are not		
	Low Halogen. Service parts obtained after purchase may not be Low Halogen.		
End-of-Life Management	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas.		
and Recycling	To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office.		
	Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is		
	greater than 90% recyclable by weight when properly disposed of at end of life.		
Hewlett-Packard	For more information about HP's commitment to the environment:		
Corporate Environmental	Clabel Citizanship Departs http://www.hp.com/hp.info/eloholeitiranship/gavenowt/index.html		
Information	Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html		
	Eco-label certifications:		
	http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html		
	ISO 14001 certificates:		
	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html		
Additional Information	This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Product is 2002/06/25		
	Directive - 2002/96/EC. • Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.		
	 Plastics parts weighing over 25 grains used in the product are marked per 150 11469 and 150 1045. This product is >90% recycle-able when properly disposed of at end of life. 		
	EPEAT Gold registered in the U.S. EPEAT registration varies by country. See www.epeat.net for		
	registration status by country		
Packaging	HP Workstation product packaging meets the HP General Specification for the Environment at		
	http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html		
	Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Contract of the Contrac		
	Environment • Poor not contain exposed enloting substances (ODS)		
	 Does not contain ozone-depleting substances (ODS) Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 		
ı	Bocs not contain neavy metals flead, mercury, cadmidition newavatent chromianis in excess of 100		



Packaging Materials	 ppm sum total for all heavy metals listed Maximizes the use of post-consumer recycled content materials in packaging materials All packaging material is recyclable All packaging material is designed for ease of disassembly Reduced size and weight of packages to improve transportation fuel efficiency Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting 	
Internal	Cushions and plastic bags made of low density polyethylene (LDPE).	
External	Outer carton, accessories carton, and insert made of corrugated paper board.	

Manageability				
Industry Standard	This product meets the following industry standard specifications for manageability functionality:			
Specifications				
	DASH 1.1 required functionalities via Intel LAN on motherboard			
	Intel Active Management Technology (AMT) 7.0			
Technology (AMT)				
	An advanced set of remote management features and functionality providing IT administrators the latest			
	and most effective tools to remotely discover, heal, and protect networked client systems regardless of			
	the system's health or power state. AMT 7.0 includes the following advanced management functions:			
	Power Management (on, off, reset)			
	Hardware Inventory (includes BIOS and firmware revisions)			
	Hardware Alerting			
	Agent Presence			
	System Defense Filters			
	SOL/IDER			
	Cisco NAC/SDN Support			
	ME Wake-on-LAN			
	DASH 1.1 compliance			
	IPv6 Support			
	• Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen,			
	periodic connections, or alert triggered connection			
	Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service			
	provider console for maintenance.			
	Remote Alerts - automatically alert IT or service provider if issues arise			
	Access Monitor - Provides oversight into Intel® AMT actions to support security requirements On Alarma Clark.			
	PC Alarm Clock Missage ft NAP Council			
	Microsoft NAP Support Host Base set up and configuration			
	 Host Base set-up and configuration Management Engine (ME) firmware roll back 			
Intel® vPro™ Technology	The HP Z620 Workstation supports Intel vPro technology when configured as outlined below:			
initet vero i recimology	The HP 2020 Workstation supports intervero technology when configured as outlined below.			
	 Intel Xeon processor E5-1600 product family or E5-2600 product family featuring Intel vPro 			
	Technology			
	Intel C602 chipset			
	Intel 82579LM GbE LAN			
Remote Manageability	The HP Z620 Workstation is supported on the following remote manageability software consoles:			
Software Solutions	,			
	LANDesk Management Suite (HP recommended solution)			
	Microsoft System Center Configuration Manager			



•	cincutons				
	HP Client Automation Enterprise				
	For questions or support for manageability needs, please visit http://www.hp.com/go/easydeploy				
System Software Manager	For questions or support for SSM, please visit: http://www.hp.com/go/ssm				
Service, Support, and	On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on-site,				
Warranty	next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8ar				
	5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offer				
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.				
	NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP				
	third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.				
	NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party				
	hardware and software. Toll-free calling and 24x7 support service may not be available in some countries. HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location.				
Product Change	Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories				
Notification	 by email to customers, based on a user-defined profile. PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support. 				



Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering
	A2A06AV	Intel Xeon E5-2620 2 15M 1333 6C 1 CPU
	A2A19AV	Intel Xeon E5-2620 2 15M 1333 6C 2 CPU
	A2A09AV	Intel Xeon E5-2643 3.3 10M 1600 4C 1 CPU
	A2A22AV	Intel Xeon E5-2643 3.3 10M 1600 4C 2 CPU
Hard Drives	Product #	Offering
	QG001AV	500GB 7200 RPM SATA 1st HDD
	QG011AV	500GB 7200 RPM SATA 2nd HDD
	QG021AV	500GB 7200 RPM SATA 3rd HDD
	QG031AV	500GB 7200 RPM SATA 4th HDD
	QG002AV	1TB 7200 RPM SATA 1st HDD
	QG012AV	1TB 7200 RPM SATA 2nd HDD
	QG022AV	1TB 7200 RPM SATA 3rd HDD
	QG032AV	1TB 7200 RPM SATA 4th HDD
Graphics	Product #	Offering
	A7U49AV	NVIDIA NVS 310 512MB GFX
	A7U50AV	NVIDIA NVS 310 512MB 2nd GFX
	A7U51AV	NVIDIA NVS 310 512MB 3rd GFX
	A7U52AV	NVIDIA NVS 310 512MB 4th GFX
	C2J48AV	NVIDIA Quadro K2000 2GB Graphics
	C2J49AV	NVIDIA Quadro K2000 2GB Graphics
Memory	Product #	Offering
		Any configuration with 2GB DDR3-1866 ECC Unbuffered DIMMs
		Any configuration with 4GB DDR3-1866 ECC Unbuffered DIMMs
		Any configuration with 4GB DDR3-1866 ECC Registered DIMMs
		Any configuration with 8GB DDR3-1866 ECC Registered DIMMs



Stable & Consistent Offerings			
Optical and Removable	Product #	Offering	
Storage	QG049AV	16X SuperMulti DVDRW SATA 1st ODD	
	QG053AV	16x SuperMulti DVDRW SATA 2nd ODD	
Input Devices	Product #	Offering	
	A8Z53AV	HP USB Keyboard (available June 2012)	
	A8Z55AV	HP USB Optical Mouse (available June 2012)	
Operating Systems	Product #	Offering	
	LJ454AV	Windows 7 Professional 64-bit OS	



Technical Specifications - Processors

Processors Intel® Xeon® Processor E5-2620 6C 2.00GHz

Intel® Xeon® Processor E5-2643 4C 3.30GHz

Introduction

The Intel® Xeon® processor E5-1600/E5-2600/E5-4600 product families are the next generation of 64-bit, multi-core enterprise processors built on 32-nanometer process technology. Throughout this document, the Intel® Xeon® processor E5-1600/E5-2600/E5-4600 product families may be referred to as simply the processor. Where information differs between the EP and EP 4S SKUs, this document uses specific Intel® Xeon® processor E5-1600 product family, Intel® Xeon® processor E5-2600 product family, and Intel® Xeon® processor E5-4600 product family notation. Based on the low-power/high performance 2nd Generation Intel® Core™ Processor Family microarchitecture, the processor is designed for a two chip platform consisting of a processor and a Platform Controller Hub (PCH) enabling higher performance, easier validation, and improved x-y footprint. The Intel® Xeon® processor E5-1600 product family and the Intel® Xeon® processor E5-2600 product family are designed for Efficient Performance server, workstation and HPC platforms. The Intel® Xeon® processor E5-4600 product family processor supports scalable server and HPC platforms of two or more processors, including "glueless" 4-way platforms. Note: some processor features are not available on all platforms.

These processors feature per socket, two Intel® QuickPath Interconnect point-to-point links capable of up to 8.0 GT/s, up to 40 lanes of PCI Express* 3.0 links capable of 8.0 GT/s, and 4 lanes of DMI2/PCI Express* 2.0 interface with a peak transfer rate of 5.0 GT/s. The processor supports up to 46 bits of physical address space and 48-bit of virtual address space.

Included in this family of processors is an integrated memory controller (IMC) and integrated I/O (IIO) (such as PCI Express* and DMI2) on a single silicon die. This single die solution is known as a monolithic processor.

Performance and Features

- Up to 8 execution cores
- Each core supports two threads (Intel® Hyper-Threading Technology), up to 16 threads per socket
- 46-bit physical addressing and 48-bit virtual addressing
- 1 GB large page support for server applications
- A 32-KB instruction and 32-KB data first-level cache (L1) for each core
- A 256-KB shared instruction/data mid-level (L2) cache for each core
- Up to 20 MB last level cache (LLC): up

Intel® Xeon® Processor E5-1620 4C 3.60GHz Intel® Xeon® Processor E5-1603 4C 2.80GHz

Processor Note

For detailed processor specifications, please refer to the Overview section at the beginning of this document.

Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2 Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2 A6S74AA

A6S77AA

Introduction

The After Market Option kits for the Z620 processors include the "2nd CPU & Memory Module", the Intel Xeon processor, and the heatsink. Additional system memory must be ordered separately.



Technical Specifications - Processors

Intel® Xeon® Processor E5-2603 v2 4C 1.80GHz Intel® Xeon® Processor E5-2609 v2 4C 2.50GHz Intel® Xeon® Processor E5-2620 v2 6C 2.10GHz Intel® Xeon® Processor E5-2630 v2 6C 2.60GHz Intel® Xeon® Processor E5-2637 v2 4C 3.50GHz Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz Intel® Xeon® Processor E5-2640 v2 8C 2.00GHz Intel® Xeon® Processor E5-2643 v2 6C 3.50GHz Intel® Xeon® Processor E5-2650 v2 8C 2.60GHz Intel® Xeon® Processor E5-2650 v2 8C 2.60GHz Intel® Xeon® Processor E5-2660 v2 10C 2.20GHz Intel® Xeon® Processor E5-2667 v2 8C 3.30GHz Intel® Xeon® Processor E5-2670 v2 10C 2.50GHz Intel® Xeon® Processor E5-2690 v2 10C 3.00GHz Intel® Xeon® Processor E5-2690 v2 12C 2.40GHz Intel® Xeon® Processor E5-2697 v2 12C 2.70GHz Intel® Xeon® Processor E5-2697 v2 12C 2.70GHz

Intel® Xeon® Processor E5-1607 v2 4C 3.00GHz Intel® Xeon® Processor E5-1620 v2 4C 3.70GHz Intel® Xeon® Processor E5-1650 v2 6C 3.50GHz Intel® Xeon® Processor E5-1660 v2 6C 3.70GHz Intel® Xeon® Processor E5-1680 v2 8C 3.00GHz

Z620 Xeon E5-2603 v2 4C 1.80 10MB 1333 CPU2	E3E04AA
Z620 Xeon E5-2609 v2 4C 2.50 10MB 1333 CPU2	E3E05AA
Z620 Xeon E5-2620 v2 6C 2.10 15MB 1600 CPU2	E3E06AA
Z620 Xeon E5-2630 v2 6C 2.60 15MB 1600 CPU2	E3E07AA
Z620 Xeon E5-2637 v2 4C 3.50 15MB 1866 CPU2	E3E08AA
Z620 Xeon E5-2640 v2 8C 2.00 20MB 1600 CPU2	E3E09AA
Z620 Xeon E5-2643 v2 6C 3.50 25MB 1866 CPU2	E3E10AA
Z620 Xeon E5-2650 v2 8C 2.60 20MB 1866 CPU2	E3E11AA
Z620 Xeon E5-2660 v2 10C 2.20 25MB 1866 CPU2	E3E12AA
Z620 Xeon E5-2667 v2 8C 3.30 25MB 1866 CPU2	E3E13AA
Z620 Xeon E5-2670 v2 10C 2.50 25MB 1866 CPU2	E3E14AA
Z620 Xeon E5-2680 v2 10C 2.80 25MB 1866 CPU2	E3E15AA
Z620 Xeon E5-2690 v2 10C 3.00 25MB 1866 CPU2	E3E16AA
Z620 Xeon E5-2695 v2 12C 2.40 30MB 1866 CPU2	E3E17AA
Z620 Xeon E5-2697 v2 12C 2.70 30MB 1866 CPU2	E3E18AA



Technical Specifications - Hard Drives

HP SAS (Serial Attached SCSI) Hard Drives for HP **Workstations**

600GB SAS 15K rpm 6Gb/s Capacity

3.5" HDD

600GB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface SAS **Synchronous Transfer** 6.0 Gb/s

Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads, **Single Track** 0.2 ms includes controller **Average** 3.4 ms overhead, including **Full Stroke** 6.6 ms settling)

Rotational Speed 15,000 rpm

Logical Blocks 1,172,123,568 - 512 byte blocks

450GB

Operating Temperature 50° to 95° F (10° to 35° C)

450GB SAS 15K rpm 6Gb/s Capacity 3.5" HDD

Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface SAS **Synchronous Transfer** 6Gb/s

Rate (Maximum)

Buffer 16MB

Seek Time (typical reads, Single Track 0.2 ms includes controller Average 3.4 ms overhead, including **Full Stroke** 6.6 ms settling)

Rotational Speed 15,000 rpm

50° to 95° F (10° to 35° C) **Operating Temperature**

300GB SAS 15K rpm 6Gb/s Capacity 3.5" HDD

300GB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm

Physical Size

Interface SAS **Synchronous Transfer** 6Gb/s

Rate (Maximum)

Buffer 16MB



4 in; 10.17 cm

Technical Specifications - Hard Drives

Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.2 ms
	Average	3.4 ms
	Full Stroke	6.6 ms
Detetional Cased	1 F 000 rpm	

Rotational Speed 15,000 rpm

Operating Temperature 50° to 95° F (10° to 35° C)

HP 300GB SAS 10K SFF HDD
 Capacity
 300GB

 Height
 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm
Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s
Rate (Maximum)

Buffer 64MB

Cache multi-segmentable cache buffer

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.4 ms (max)Average
Full Stroke3.6 ms7.3 ms

Rotational Speed 10,000 rpm **Logical Blocks** 585,937,500

Operating Temperature 41° to 131° F (5° to 55° C)

HP 600GB SAS 10K SFF HDD
 Capacity
 600GB

 Height
 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s
Synchronous Transfer Up to 600MB/s
Rate (Maximum)

Buffer 64MB

Cache multi-segmentable cache buffer

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.4 ms (max)Average
Full Stroke3.6 ms7.3 ms

Rotational Speed 10,000 rpm **Logical Blocks** 1,172,123,568

Operating Temperature 41° to 131° F (5° to 55° C)

Technical Specifications - Hard Drives

HP 900GB SAS 10K SFF HDD

900GB Capacity

Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface SAS 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Cache multi-segmentable cache buffer

Seek Time (typical reads, Single Track 0.2ms (max) includes controller 3.5ms Average overhead, including **Full Stroke** 7.0ms settling)

Rotational Speed 10,000 rpm **Logical Blocks** 1,758,174,767

Operating Temperature 41° to 131° F (5° to 55° C)

HP 1.2TB SAS 10K SFF HDD Capacity 1.2TB

> Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

Interface SAS 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, 0.18ms (max) Single Track includes controller Average 3.5ms overhead, including **Full Stroke** 7.17ms settling)

Rotational Speed 10,000 rpm **Logical Blocks** 2,344,225,968

Operating Temperature 41° to 131° F (5° to 55° C)

SATA (Serial ATA) Hard **Drives for HP** Workstations

250GB SATA 10K rpm SFF HDD

Capacity 250GB

Height 0.6 in; 1.53 cm

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s)

Synchronous Transfer Up to 600MB/s

Buffer 64MB

Rate (Maximum)

Technical Specifications - Hard Drives

JIIS - Halu Dilves			
	Cache	Adaptive	
	Seek Time (typical reads,	Single Track	1.2ms (typical)
	includes controller overhead, including settling)	Average	3.6ms
		Full Stroke	9.0ms (typical)
	Rotational Speed	10K rpm	
	Operating Temperature	41° to 131° F (5° to 55° (<u>.</u>)
500GB SATA 10K rpm SFF	Capacity	500GB	
HDD	Height	0.6 in; 1.53 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
	Interface	Serial ATA (6Gb/s)	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
	Buffer	64MB	
	Cache	Adaptive	
	Seek Time (typical reads,	Single Track	1.2ms (typical)
	includes controller overhead, including settling)	Average	3.6ms
		Full Stroke	9.0ms (typical)
	Rotational Speed	10K rpm	
	Operating Temperature	41° to 131° F (5° to 55° (<u>-</u>)
1TB SATA 10K rpm SFF	Capacity	1TB	
HDD	Height	0.6 in; 1.53 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
	Interface	Serial ATA (6Gb/s)	
	Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
	Buffer	64MB	
	Cache	Adaptive	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	1.2ms (typical)
		Average	3.6ms
		Full Stroke	9.0ms (typical)
	Rotational Speed	10K rpm	
	Operating Temperature	41° to 131° F (5° to 55° (<u>.</u>)
500GB SATA 7200 rpm	Capacity	500GB	



Technical Specifications - Hard Drives

6Gb/s 3.5" HDD	Height	0.6 in; 1.53 cm
טעטוז כ.כ פועטט	Height	0.6 in; 1.53 d

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s

Buffer 16MB

Cache Segmentable

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2 msAverage
Full-Stroke11 ms21 ms

Rotational Speed 7,200 rpm **Logical Blocks** 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s Capacity

3.5" HDD

Capacity 1 Terabyte (1000 GB)

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600 MB/s

Cache 32 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2 msAverage
Full-Stroke11 ms21 ms

Rotational Speed 7,200 rpm **Logical Blocks** 1,953,525,168

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 2TB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer

Rate (Maximum)

Up to 600 MB/s

Cache 64MB

Technical Specifications - Hard Drives

Seek Time (typical reads,	Single Track	2 ms
includes controller overhead, including settling)	Average	11 ms
	Full-Stroke	21 ms
Potational Speed	7 200 rpm	

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity3.0TBHeight1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Up to 6.0 Gb/s

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Rate (Maximum)

num)

Buffer 64MB

Seek Time (typical reads, includes controller overhead, including settling)

Single Track

Average

Full-Stroke

Average 11 ms
Full-Stroke Not specified

0.6 ms

Rotational Speed 7200 rpm

Operating Temperature 41° to 140° F (5° to 60° C)

500GB SATA 7.2K SED SFF Capacity HDD Height

 Capacity
 500GB

 Height
 0.275 in; 0.7 cm

WidthMedia Diameter2.5 in; 6.36 cmPhysical Size2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s)

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 32MB

Seek Time (typical reads, includes controller overhead, including settling)

Single Track 1 ms

4.2 ms

Full-Stroke 25 ms (typical)

settling) Full-Stroke
Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

Technical Specifications - Hard Drives

HP Solid State Drives (SSDs) for Workstations

HP 128GB SATA 6Gb/s SSD Capacity 128GB

Height 0.28 in; 0.7 cm

Width Physical Size 2.5 in; 6.36 cm

Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s SSD Capacity 256GB

Height 0.28 in; 0.7 cm **Interface** SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s SED Capacity 256GB

SSD

Height 0.28 in; 0.7 cm

Width Physical Size 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 512GB SATA 6Gb/s SSD Capacity 512GB

Height 0.28 in; 0.7 cm

Width Physical Size 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

Seagate 600 Pro 120GB

SATA SSD

Capacity 120GB

Height 0.276 in; 0.7 cm

Width Physical Size 2.76 in; 7.01 cm

Interface SATA 6Gb/s
Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)



Technical Specifications - Hard Drives

Seagate 600 Pro	240GB
CATA CCD	

SATA SSD

240GB Capacity

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.76 in; 7.01 cm

Interface SATA 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Seagate 600 Pro 480GB

SATA SSD

Capacity 480GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.76 in; 7.01 cm

Interface SATA 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Intel Pro 1500 180GB

SATA SSD

Capacity 180GB

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA **Synchronous Transfer** 600 Mb/s

Rate (Maximum)

Samsung SM843T 240GB

SATA SSD

Capacity 240GB

Width **Physical Size** 2.5 in; 6.36 cm

Interface SATA 6Gb/s **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

2.76 in; 7.01 cm

PCIe SSDs for HP **Workstations**

Fusion ioFX 410GB PCIe

Accelerator

Capacity 410GB

Interface PCI Express 2.0 x4 electrical x4 physical

Operating Temperature 32° to 95° F (0° to 35° C)

Technical Specifications - Hard Drive Controllers

LSI 9217-4i4e 8-port SAS PCI Bus 6Gb/s RAID Card

PCI Bus 8 lanes, PCI Express 3.0

RAID Levels Offers Integrated RAID (0, 1, 1E and 10)

PCI Data Burst Transfer Half Duplex x8, PCIe, 8000 MB/s

Rate

SAS Bandwidth Half Duplex 600 MB/s per lane

 PCI Card Type
 3.3V Add-in Card

 PCI Voltage
 12 V ± 10%

PCI Power 9.8W typical, Airflow min 200 LFM

BracketFull height and low profileCertification LevelPCI Express 3.0 compliantSAS ProcessorLSI SAS2308/ Fusion MPT 2.0

Internal ConnectorsOne x4 internal mini-SAS (SFF8087)External ConnectorsOne x4 external mini-SAS (SFF8088)Maximum Number of SCSI256 Non-RAID SAS/SATA devices

Devices

.

LED Indicators N/A

LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card and iBBU08 Battery Backup Unit PCI Bus PCI-Express (Gen2) V2.0 x8 lanes

PCI Modes Bus Master DMA
RAID Levels RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

PCI Data Burst Transfer

Rate

Up to 4GB/s

PCI Card Type Low profile, single PCIe slot design with full height bracket.

The optional iBBU08 Battery Backup unit mounts on the controller card and

the assembly remains within a single PCIe slot width.

PCI Voltage +3.3V Add-in Card

PCI Power 12.5 Watts
Certification Level PCI-Express 2.0

IO Bus Eight 3 Gb/s and 6Gb/s compatible SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4

External Connectors None **Maximum Number of SCSI** 32.

Devices NOTE: HP Workstations do not support this many internal drives.

LED Indicators Connector LEDs indicate whether the internal connector is active for ports 0-3

and 4-7



Technical Specifications - Hard Drive Controllers

LSI 9270-8i SAS 6Gb/s ROC PCI Bus x8 lane PCle 3.0 compliant

RAID Card and iBBU9
Battery Backup Unit

RAID Levels RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

PCI Card Type Low profile, single PCIe slot design with full height bracket.

PCI Voltage +3.3V Add-in Card
PCI Power +3.3V, +12V
Certification Level PCI-Express 3.0

IO Bus Eight 6Gb/s and 3Gb/s compatible SAS/SATA ports

SAS Processor LSISAS2208 Dual-Core RAID on Chip (ROC)

Internal Connectors Two SAS SFF8087 x4 (Mini-SAS)

External Connectors None

Maximum Number of SCSI Up to 128 SAS and/or SATA hard drives and SSDs

Devices NOTE: HP Workstations do not support this many internal drives.

LED Indicators Heartbeat LED on card



Technical Specifications - Graphics

NVIDIA NVS 310 512MB Graphics

Form Factor Low Profile:

2.713 inches in height × 6.150 inches in length

Weight: ~142 grams

Graphics Controller NVIDIA NVS 310

GPU: GF119-825

Bus Type PCI Express x16, 2.0 compliant

Memory Size: 512MB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors 2 x DisplayPort

Maximum Resolution Up to 2560 x 1600 (digital display) per display. Image Quality Features The following video formats are supported:

- MPEG2

- MPEG4 Part 2 Advanced Simple Profile

- H.264 SVC codec support- Support for 3D Blu Ray

- VC1

- DivX version 3.11 and later

- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

Display Output

Up to 2 displays in the following configurations:

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up to 2560
 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort 1.2 multi stream topology technology.

DVI-D output:

- Drives two digital display at resolutions up to 1920 x 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors
- Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

HDMI output:

 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

VGA display output:



Technical Specifications - Graphics

Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz

using DisplayPort to VGA cable adaptors **Shading Architecture** Shader Model 5.0

Supported Graphics APIs DX11, OpenGL 4.1

Available Graphics

Windows 8 **Drivers**

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 19.5 Watts

1. The thermal solution used on this card is an active fan heatsink. Note

2. Factory configured NVS 310 graphics card have no cable adpaters included.

Adapters must be ordered separately.

3. Option kit NVS 310 includes 2 DP to DVI-D cable adapters.

NVIDIA NVS 315 1GB Graphics (for HP Workstations)

Form Factor Low Profile:

2.713 inches in height × 5.7 inches in length

Weight: ~142 grams

Graphics Controller NVIDIA NVS 315 (using GF119-825 GPU)

Number of Cores: 48 CUDA cores

Max. Power: 19.3W

Cooling Solution: Active fan heatsink

Bus Type PCI Express x16, 2.0 compliant

Memory Size: 1GB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors DMS-59 output

Cables included:

- For CTO: DMS-59 to DVI cable

For AMO: DMS-59 to DVI cable and DMS-59 to VGA cable

Maximum Resolution Maximum number of displays supported: 2

Maximum Resolution Support:

- DMS-59 to VGA: 2048 x 1536 @ 85Hz - DMS-59 to DVI: 1980 x 1200 @ 60Hz - DMS-59 to DP: 2560 x 1600 @ 60Hz

Image Quality Features See Display Output section.

The following video formats are supported:

- MPEG2



Technical Specifications - Graphics

- MPEG4 Part 2 Advanced Simple Profile

- H.264 SVC codec support

- Support for 3D Blu Ray

VC1

- DivX version 3.11 or later

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 315 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

Display Output

Up to 2 displays using one of the following DMS-59 cables:

DMS-59 to DVI DMS-59 to VGA DMS-59 to DP

DisplayPort output:

- Drives two DisplayPort enabled digital displays at resolutions up to 2560 \times 1600 at 60 Hz with reduced blanking, when connected via the DMS-59 to DP adapter.

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DMS-59 to DVI-D single-link cable adaptor

VGA display output:

 Drives two analog display at resolutions up to 2048 × 1536 at 85 Hz using DMS-59 to VGA cable adaptor.

Shading Architecture Supported Graphics APIs

Shader Model 5.0 DX11, OpenGL 4.3

Available Graphics

Drivers

Windows 8

Microsoft Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com/

Notes

The thermal solution used on this card is an active fan heatsink.
 Factory configured graphics card includes DMS-59 to DVI cable.

3. Option kit graphics card includes DMS-59 to DVI and DMS-59 to VGA cables

(one each).

NVIDIA NVS 510 2GB

Form Factor

Low Profile, 2.713 inches × 6.3 inches, single slot



Technical Specifications - Graphics

Graphics

Graphics Controller NVS 510 GPU

> Core Clock: 797 Mhz Memory Clock: 891 Mhz

CUDA Cores: 192

Bus Type PCI Express x16, Generation 2.0

2GB DDR3 Memory

Connectors Four mini-DisplayPort.

Four mini-DisplayPort to DisplayPort adapters included.

(DisplayPort to DVI-D, DisplayPort to VGA, DisplayPort to HDMI, and DisplayPort to Dual-Link DVI adapters available as separate accessories)

Maximum Resolution Mini-DisplayPort connectors support ultra-high-resolution panels (up to 3840

x 2160 @ 60Hz)

NOTE: This card supports up to four displays. For Windows XP, only 2 active

displays are supported.

Image Quality Features

10-bit internal display processing, including hardware support for 10-bit scan-

out

Display Output DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2)

support.

Digital Display Support

1. DisplayPort Output

- Drives four DisplayPort enabled digital display at resolutions up to 3840 × 2160 at 60 Hz with reduced blanking, when connected natively using the 4

DisplayPort connectors on the NVS 510 graphics card.

- DisplayPort Multi-Stream Topology (MST) Technology: Supports various combinations of display resolutions and number of displays when using DisplayPort multi stream topology technology - up to a maximum of 4 monitors at a resolution of 1920 × 1200 at 60 Hz with reduced blanking.

2. DVI-D Output

- Drives four digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors.

- Drives four digital displays at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors.

3. HDMI Output

- The NVS 510 graphics board is capable of driving four high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI

cable adaptors.

Analog Display Support

1. VGA display output

- Drives four analog displays at resolutions up to 1920 × 1200 at 60 Hz using

DisplayPort to VGA cable adaptors.

Supported Graphics APIs Full Microsoft DirectX 11, Shader Model 5.0 support

Full OpenGL 4.3 support

Available Graphics Genuine Windows 7 Professional (64-bit and 32-bit)



Technical Specifications - Graphics

Drivers Microsoft Windows XP Professional (64-bit and 32-bit)

> Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Power Consumption

33.4 Watts

Note Heatsink cooler design is active.

Graphics Cable Adapter option choice is available starting Feb 1 2013 for the **Graphics Cable Adapters** Note

following graphics cards:

NVS 310, Quadro 410, Qaudro K5000, FirePro V3900, FirePro W7000

New Graphics Cards introduced after Feb 1 2013 will be eligible for choosing

Graphics Cable Adapters, unless otherwise specified.

No cable choice for NVS 300, NVS 510.

Maximum number of cables allowed is 8.

NVIDIA Quadro 410 512MB Graphics

Form Factor Low Profile:

2.713 inches × 5.7 inches, single slot

Graphics Controller NVIDIA Quadro 410

GPU: GK107

Bus Type PCI Express x16, 3.0 compliant

Size: 512MB DDR3 Memory

Clock: 900MHz

Memory Bandwidth: 14GB/s

One dual-link DVI-I connector Connectors

One DisplayPort connector

Maximum Resolution VGA (through DVI to VGA cable):

• 2048 × 1536 × 32 bpp at 85 Hz

Dual-link DVI

2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link DVI

1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort 1.2

• 3840 × 2160 × 36 bpp at 60 Hz

RAMDAC 400 MHz integrated RAMDAC

Display Output Maximum number of displays supported: 2



Technical Specifications - Graphics

Shading Architecture Shader Model 5.0
Supported Graphics APIs DX11, OpenGL 4.2

Available Graphics Windows 8

DriversGenuine Windows 7 Professional (64-bit and 32-bit)
Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com/

Notes 1. Factory configured Quadro 410 does not include any video adapters.

Adapters must be ordered separately.

2. Option kit Quadro 410 includes one DP to DVI-D adapter

NVIDIA Quadro K600 1GB Form Factor

Graphics

Form Factor 2.731" H x 6.3" L

Single Slot, Low Profile

Full Height Profile bracket installed Low Profile bracket included

Graphics Controller NVIDIA Quadro K600 Graphics Card

Kepler GK107 GPU 192 CUDA cores Max Power: 41 Watts PCI Express 2.0 x16

Memory 1 GB GDDR3, 891 Mhz 128-bit memory I/O path 29 GB/s memory bandwidth

Connectors 1 DL-DVI(I) output, 1 DisplayPort output

CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

Maximum Resolution DisplayPort:

Bus Type

- up to 3840 x 2160 x 30 bpp @ 60Hz

supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output VGA:

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

- 400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz



Technical Specifications - Graphics

DL-DVI(I):

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

- Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to the Quadro K600 DisplayPort connector at this resolution)

- Max number of daisy-chained monitors: 2

Shading Architecture

Full Microsoft DirectX 11 Shader Model 5.0

Supported Graphics APIs

OpenGL 4.3

DirectX 11

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes

- 1. Quadro K600 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.
- 2. Quadro K600 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.
- 3. Quadro K600 is Windows 8 Compliant.
- 4. A total maximum of 2 active monitors are supported across all display output types.



Technical Specifications - Graphics

AMD FirePro V3900 1GB Graphics

Form Factor Full height, half length (full-height bracket included)

Graphics Controller AMD FirePro™ V3900 professional graphics

Bus Type PCI Express® x16, Generation 2.1

Memory 1GB DDR3 memory
Connectors 1 DL DVI, 1 DP output

One DP to DVI adapter included

Maximum Resolution 2560x1600 per display (5120x1600 max. horizontal resolution)

Display Output 1 DisplayPort® 1.2

1 Dual-link DVI

Supported Graphics APIs OpenCL™ 1.1, DirectX® 11 and OpenGL 4.2

Available Graphics

Drivers

Genuine Windows® 7 Professional (64-bit and 32-bit)
Genuine Windows Vista® Business (64-bit and 32-bit)
Microsoft® Windows XP® Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays

varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort™ active or

passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s) may be required. See

www.amd.com/firepro for details.

NVIDIA Quadro K2000 2GB Form Factor

Graphics

4.38" H x 7.97" L Single Slot, Full Height

Graphics Controller NVIDIA Quadro K2000 Graphics Card

<50W

Kepler GK107 GPU 384 CUDA cores Max Power: 51.1 Watts PCI Express 2.0 x16

Bus TypePCI Express 2.0 x16Memory2 GB GDDR5, 2000 Mhz128-bit memory I/O path

64 GB/s memory bandwidth

Connectors 1 DL-DVI(I) output, 2 DisplayPort outputs

CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

Technical Specifications - Graphics

Maximum Resolution DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features

10-bit internal display processing pipeline

10-bit scan-out support

Display Output VGA:

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

- 400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I):

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

- Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K2000 DisplayPort connector at this resolution) - Max number of DisplayPort daisy-chained monitors or hub connected

monitors from a single Quadro K2000 DisplayPort connector: 4 with maximum

resolution of 1920 x 1200

Maximum number of monitors across all available Quadro K2000 outputs is 4.

Shading Architecture

OpenGL 4.3

Supported Graphics APIs

DirectX 11

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

Full Microsoft DirectX 11 Shader Model 5

HP qualified drivers may be preloaded or available from the HP support Web

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com



Technical Specifications - Graphics

Notes

- Quadro K2000 offered as CTO does not include a video cable adapter.
 Video cable adapters must be ordered separately.
- 2. Quadro K2000 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.

NVIDIA Quadro K4000 3GB Form Factor

Graphics

4.376" H x 9.5" L

Single Slot, Full Height

Graphics Controller NVIDIA Quadro K4000 Graphics Card

Kepler GK106 GPU 768 CUDA cores Max Power: 80 Watts PCI Express 2.0 x16

Bus TypePCI Express 2.0 x16Memory3 GB GDDR5, 2800 Mhz192-bit memory I/O path

134 GB/s memory bandwidth

Connectors 1 DL-DVI(I) output, 2 DisplayPort outputs

CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

Maximum Resolution D

DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

Image Quality Features

10-bit internal display processing pipeline

• 10-bit scan-out support

Display Output

VGA:

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

- 400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I):

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

- Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to a Quadro K4000 DisplayPort connector at this resolution)

 Max number of DisplayPort daisy-chained monitors or hub connected monitors from a single Quadro K4000 DisplayPort connector: 4 with maximum

resolution of 1920 x 1200

HDMI:



Technical Specifications - Graphics

- Requires use of DP-to-HDMI cable

- Max Resolution: 1920 x 1080 x 32 bpp @ 60Hz

Maximum number of monitors across all available Quadro K4000 outputs is 4.

Shading Architecture

Full Microsoft DirectX 11 Shader Model 5.0

Supported Graphics APIs

OpenGL 4.3 DirectX 11

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics
Drivers

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com/

Notes

1. Quadro K4000 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.

2. Quadro K4000 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.

3. Quadro K4000 is Windows 8 Compliant.

4. A total maximum of 4 active monitors are supported across all display output types. To get 4 monitors, at least one monitor must be daisy chained on a DisplayPort output.

5. A DisplayPort hub device may be used to connect multiple DisplayPort monitors to a single Quadro K4000 DisplayPort output.

NVIDIA Quadro K5000 4GB Form Factor

Graphics

4.376" H x 10.5" L

Dual Slot

Graphics Controller

NVIDIA Quadro K5000 Graphics Card based on the GK104 GPU

Bus Type

PCI Express 2.0 x16

Memory

173GB/s memory bandwidth

Connectors

7 3 db/3 illelilol y balluwlutii

DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-DIN

connector.

4GB GDDR5

No adapter included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to Dual-

Link DVI adapters available as accessories



Technical Specifications - Graphics

Image Quality Features

- DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2), HDMI 1.4, and HDCP support
- NVIDIA 3D Vision™ technology

Display Output

400 MHz integrated RAMDAC

Maximum resolution over VGA (through DVI to VGA cable): 2048 × 1536
 × 32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

 Maximum resolution over digital port (single GPU and SLI mode): 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

 Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.

Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz

HDMI

Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz

Supported Graphics APIs

OpenGL 4.2

DirectX 11 Shader model 5.0 Support

API support for NVIDIA's CUDA™ C, CUDA C++, DirectCompute 5.0, OpenCL,

Java, Python, Fortran

Available Graphics Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Power Consumption

122 Watts

Note

No display output adapter included.



Technical Specifications - Graphics

AMD FirePro W7000 4GB Graphics

Form Factor Full height, full length, single slot

Graphics Controller AMD FirePro™ W7000 Professional Graphics

Max Power: <150 Watts

Bus Type PCI Express™ x16, Generation 3.0

Memory4GB GDDR5, 153.6 GB/s bandwidth, ECC supportConnectors4 x DisplayPort with HBR2 and MST support.

Maximum Resolution DisplayPort: 4096x2160 @24bpp 60Hz

Dual Link DVI: 2560x1600 (requires DP to DL-DVI adapter) Single Link DVI: 1920x1200 (requires DP to DVI adapter)

VGA: 1920x1200 (requires DP to VGA adapter)

Image Quality Features

Display Output Max no

Max number of monitors supported using DisplayPort: 6

Monitor chaining from a single DisplayPort options(subject to a max of 6 total monitors across all outputs, requires use of DisplayPort Monitors supporting MST or the use of DisplayPort hubs):

Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component

1 4096x2169 display2 2560x1600 displays4 1920x1200 displays

Shading Architecture

Shader Model 5.0

Supported Graphics APIs

OpenGL® 4.2 with OpenGL Shading Language

OpenCL 1.1

Microsoft® DirectX® 11.1

Available Graphics

Drivers

Windows 8

Windows 7 Professional (64-bit and 32-bit)

Windows 8 (64bit and 32-bit)
Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Note

1. AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's

DisplayPort™ or Mini-DisplayPort™ connector(s) may be required. See www.amd.com/firepro for details.

2. Factory configured FirePro W7000 graphics card does not include any video adapter cables. Adapters must be ordered separately.

3. Option Kit FirePro W7000 graphics card does not include any video cable adapters. Adapters must be ordered seperately.

Technical Specifications - Graphics

NVIDIA Quadro K6000 12GB Graphics **Form Factor** 4.376" H x 10.5" L

Dual Slot

Power: 234 Watts Weight: ~880 grams

Graphics Controller NVIDIA Quadro K6000 Graphics Card based on the GK180 GPU

Core Count: 2880 Base Clock: 797 MHz Boost Clock: 902 MHz PCI Express 3.0 x16

Memory 12GB GDDR5

Bus Type

384-bit memory I/O path 288 GB/s memory bandwidth

ECC Memory

Connectors DVI-I (1), DVI-D (1), DP (2), Optional 3D Stereo bracket with 3-pin mini-DIN

connector.

Factory configured option: No adapter included with card.

Option Kit: No adaptor included with card.

DVI to VGA, DisplayPort to VGA, DisplayPort to DVI, and DisplayPort to Dual-

Link DVI adapters available as accessories.

Maximum Resolution Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Image Quality Features

(HBR2), HDMI 1.4, and HDCP support
 NVIDIA 3D Vision™ technology

NVIDIA Premium Mosaic and nView

Display Output 400 MHz integrated RAMDAC

Maximum resolution over VGA (through DVI to VGA cable): 2048 × 1536

× 32 bpp at 85 Hz

Dual-link internal TMDS (DVI 1.0)

 Maximum resolution over digital port (single GPU and SLI mode): 2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link internal TMDS (DVI 1.0)

 Maximum resolution over digital port (single GPU and SLI mode):1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort with MST and HBR2.

Maximum resolution: 3840 × 2160 × 36 bpp at 60Hz

HDMI

Maximum resolution: 1920 × 1080 × 32 bpp at 60Hz



Technical Specifications - Graphics

Shading Architecture Shader Model 5.0

Full IEEE 764-2008 32-bit and 64-bit precision

Supported Graphics APIs Full OpenGL 4.3

Full DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics

Drivers

Windows 8

Windows 7 Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Notes 1. NVIDIA GRID VGX Pass Through feature supported on NVIDIA Quadro K6000

to enable direct mapping of GPU to Virtual Machine.

2. No display output adapter included.



Technical Specifications - High Performance GPU Computing

NVIDIA Tesla K20c Compute Processor **Form Factor** 4.376 inches by 10.5 inches

Dual Slot

System Interface PCI Express Gen2 ×16

Video Outputs None.

Memory 5GB GDDR5, 320-bit memory path

Peak Memory Bandwidth 208 GB/s (with ECC off)

Supported APIs CUDA and OpenACC API support includes:

CUDA C, CUDA C++, Java, Python, and Fortran

Supported Operating

Systems

Windows 8 (64-bit)
Genuine Windows 7 Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores GK110 GPU, 706 MHz clock

2496 CUDA cores

Power Consumption ~225 Watts

NOTE 1: A 1125W PSU is required for any K20 configuration on the Z820

NVIDIA Tesla K40 Compute Processor Form Factor Size: 4.376 inches by 10.5 inches

Slots: Dual Slot

Power Connectors: One 6-pin and one 8-pin

Weight: ~826 grams PCI Express Gen3 ×16

System Interface PCI Express G

Video Outputs None.

Memory 12GB GDDR5,

memory path: 384-bit memory clock: 3Ghz

Peak Memory Bandwidth 288 GB/s

Supported APIs CUDA, OpenACC, OpenCL 1.2 API support includes:

C, C++, Java, Python, and Fortran

Supported Operating

Systems

Windows 8 (64-bit)

Genuine Windows 7 Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html



Technical Specifications - High Performance GPU Computing

Novell SUSE Linux Enterprise drivers may also be obtained from:

ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores GK110B GPU

Base Clock: 745 MHz Boost Clock: up to 875 Mhz

2888 CUDA cores

Power Consumption ~235 Watts

Note 1: A 1125W PSU is required for any K40 configuration on the Z820

Tesla K40 GPU Boost By default the Tesla K40 active ships with the core clock set to the base clock.

HPC workloads can have one or more characteristics as described. When selecting one of the supported boost clocks a good strategy is to characterize the workload with the available boost clocks. For example, DGEMM/Linpack are extremely demanding on power. Therefore, the "base clock" may be the correct choice when running Linpack. Some workloads in life sciences, manufacturing, CFD, CAD, etc., may have power headroom and can take

advantage of one of the boost clocks.



Technical Specifications - Multimedia and Audio Devices

HP Thin USB Powered Speakers

Frequency Response (-

FO to 20kHz

3dB, 24-bit/96kHz input)

Dimensions Speakers: 14.52 x 9.50 x 2.45 cm (5.72 x 3.74 x 0.96 in) per speaker



Technical Specifications - Optical and Removable Storage

HP DVD-ROM Drive

Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up to 8.5

GB

Access Times DVD-ROM Single Layer < 140 ms (typical)

 CD-ROM Mode 1
 < 125 ms (typical)</td>

 Full Stroke DVD
 < 250 ms (seek)</td>

 Full Stroke CD
 < 210 ms (seek)</td>

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA maximum

12 VDC - < 600 mA typical, < 1400 mA maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing) **Relative Humidity** 10% to 90% **Maximum Wet Bulb** 86° F (30° C)

Temperature

Operating Systems
Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista

Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation.

Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

HP DVD+/-RW Drive

Description 5.25-inch, half-height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 17.5 cm (5.9 x 1.7 x 8.0 in)

Disc Formats DVD-RAM

DVD+R
DVD+RW
DVD+R DL
DVD-R DL
DVD-R
DVD-R



Technical Specifications - Optical and Removable Storage

CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

> **Full Stroke DVD** < 240 ms (seek) **Full Stroke CD** < 200 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 40X

CD-RW Up to 32X

DVD ROM Read DVD-RAM Up to 12X

> DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 12X DVD-R DL Up to 12X DVD-ROM Up to 16X DVD-ROM DL Up to 12X DVD+R Up to 16X DVD-R Up to 16X

Power Source SATA DC power receptacle

> 5 VDC ± 5%-100 mV ripple p-p **DC Power Requirements**

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC -<1000 mA typical, <1600 mA maximum

12 VDC -<1200 mA typical, <2000 mA maximum

Operating Environmental Temperature

(all conditions noncondensing)

Relative Humidity

Maximum Wet Bulb Temperature

Operating Systems

Supported

41° to 122° F (5° to 50° C)

10% to 90% 86° F (30° C)

Windows 8 32-bit and 64-bit, Windows 7

Professional 32-bit and 64-bit.

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the operating system.

Kit Contents HP SATA SuperMulti DVD Writer Drive, Roxio Easy

> Media Creator software, Intervideo WinDVD Software, installation guide, and DVD+R media.

HP Blu-Ray Writer

Description 5.25-inch, half-height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA



Technical Specifications - Optical and Removable Storage

Dimensions (WxHxD)	15.0 x 4.4 x 20.3 cm (5.9 x	1.7 x 8.0 in)	
Disc Formats	BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-R DVD-R CD-R CD-R		
Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB stan	
	Blu-ray	50 GB DL or 25 GB stand	ard
	Full Stroke DVD	< 250 ms (seek)	
	Full Stroke CD	< 210 ms (seek)	
	Blu-ray	<275 ms (seek)	
	Startup Time (Time to	BD-ROM (SL/DL)	255 / 285
	drive ready from tray loading)	BD-R (SL/DL)	255 / 285
	toaumy)	BD-RE (SL/DL)	255 / 285
		DVD-ROM (SL/DL)	185 / 185
		DVD-R (SL/DL)	25S / 25S
		DVD-RW	25S
		DVD+R (SL/DL)	25S / 25S
		DVD+RW	25S
		DVD-RAM	45S
		CD-ROM	45S
Maximum Data Transfer	CD ROM Read	CD-ROM	Up to 40X
Rates		CD-R	Up to 40X
	DVD ROM Read	CD-RW DVD-RAM	Up to 40X
	שאט אטויו אפמע		Up to 5X
		DVD+RW DVD-RW	Up to 10X Up to 10X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-ROM	Up to 16X
		DVD-ROM DL	
		DVD-ROM DL DVD+R	Up to 8X
	Plu Pau		Up to 12X
		DVD-R	Up to 12X
	Blu-Ray	BD-ROM DI	Up to 6X
		BD-ROM DL	Up to 4.8X
		BD-R	Up to 6X



Technical Specifications - Optical and Removable Storage

BD-R DL Up to 4.8X BD-R Up to 6X BD-RE SL/DL Up to 4.8X

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 10%-100 mV ripple p-p

DC Current 5 VDC -900 mA typical, 1200 mA maximum

86° F (30° C)

12 VDC -1000 mA typical, 1600 mA maximum

Operating Environmental Temperature

(all conditions noncondensing)

41° to 122° F (5° to 50° C) **Relative Humidity** 15% to 80%

Maximum Wet Bulb

Temperature

Operating Systems Supported

Windows 7 Professional 32-bit and 64-bit. Windows Vista Business 64*, Windows Vista

Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation,

SUSE Linux Enterprise Desktop 10 & 11

* No driver is required for this device. Native support is provided by the operating system.

** RHEL WS4 not supported on Z200/Z200SFF

Kit Contents HP Blue Laser RW Drive, Roxio Easy Media Creator

software, Intervideo WinDVD Software,

installation quide.

Disclaimer As Blu-Ray is a new format containing new technologies, certain disc, digital

> connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD

movies cannot be played on this workstation.

HP DX115 Removable Drive Enclosure

Interface Type

Dimensions (WxHxL)

Compatible with SAS or SATA controllers 147.6 x 41.1 x 205 mm (5.81 x 1.62 x 8.08 in)

Weight

Frame and Carrier: 1.73 kg (3.8 lbs)

Carrier: 0.45 kg (1 lbs)

Technical Specifications - Controller Cards

HP IEEE 1394b FireWire PCIe Card

Data Transfer RateSupports up to 800 MbpsDevices SupportedIEEE-1394 compliant devicesBus TypePCIe card full height PCIe slots

Ports Two IEEE-1394b bilingual 9-Pin connectors (Rear)

Internal Connectors One 10-Pin Header connector

System Requirements Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP

Professional, Windows XP Home, Windows Vista, SLED 11 and RHEL 6. Intel Pentium® G series or higher processor, 128-MB RAM, 1-GB Hard Drive, CD-ROM

drive, built in sound system, Available PCIe slot.

Temperature – Operating 50° to 131° F (10° to 55° C)

Temperature – Storage –22° to 140° F (–30° to 60° C)

Relative Humidity –

Operating

20% to 80%

peracing

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit, RHEL 6 and

SLED 11.

HP Thunderbolt-2 PCIe 1- Data Transfer Rate port I/O Card Davices Supported

Data Transfer Rate Supports up to 20 Gb/s (20,000 Mb/s)

Devices Supported Thunderbolt[™] certified devices

Bus Type PCIe card, full or half height PCIe slots

Ports One Thunderbolt™ 2 external 20-Pin output connectors (Rear)

Internal Connectors One 5-Pin header connector

System Requirements Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit, Intel i5

series or higher processor, 128-MB RAM, 1-GB Hard Drive, available PCIe slot.

Temperature - Operating

50° to 131° F (10° to 55° C)

Temperature - Storage

-22° to 140° F (-30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Compliances

ices FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Genuine Windows 7 Professional 64-bit, Genuine Windows 8.1 64-bit.

Kit Contents

HP Thunderbolt™ 2 PCIe 1-port I/O Card, full height and half height bracket,

DisplayPort to DisplayPort cable, internal header cables(2), user

documentation and warranty card.

Warranty The HP Thunderbolt™ 2 PCle 1-port I/O Card has a one-year Limited Warranty

or the remainder of the warranty of the HP supported product in which it is installed. Technical support is available seven days a week, 24 hours a day, by phone, as well as online support forums. Certain restrictions and exclusions

apply.



Technical Specifications - Networking and Communications

Integrated Intel 82579LM Connector
PCIe GbE Controller Controller

Connector RJ-45

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCIe-based interface for active state operation (SO state) and SMBus for host

and management traffic (Sx low power state)

Power Requirement Requires 3.3V and 1.05V or just 3.3V with integrated regulators

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostic.
AMT 7.0 support

Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC **Connector** RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory8 MB NVRAM serial FlashData Rates Supported10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

Hardware Certifications FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for Taiwan,

VCCI for Japan, MIC for Korea, GOST for Russia, UL listed (E212044), European

Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

Boot ROM Support Yes

Network Transfer Mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)

Technical Specifications - Networking and Communications

Operating Humidity 131° F (55° C) with 5% to 95% non-condensing humidity

Dimensions 7 cm x 10.5 cm (2.75 in x 4.13 in), low profile compatible

Operating System Driver

Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XP x64

Red Hat Enterprise Linux (RHEL) 5, 6; Novell SLED 10 & 11

Management Capabilities ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility, ASF2.0,

DASH 1.0 and DASH 1.1 profiles

Kit Contents Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme Gigabit

Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick install guide, product

warranty statement

Intel Gigabit CT Desktop NIC **Connector** RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x

flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware Certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for

European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C) **Operating Humidity** 85% at 131° F (55° C)

Dimensions 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)

Operating System Driver

Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64, Windows Vista Business 32, Windows XP Professional, Windows XP x64. Red Hat Enterprise Linux 4 (RHEL4.8 or newer)*, Red Hat Enterprise Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6, SUSE Linux Enterprise

Desktop (SLED) 11

RHEL 4 and 5, SLED 10, are not supported on the Z220 CMT/SFF

Management Capabilities WOL, PXE, DMI, WFM 2.0

Kit Contents Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel PROset II

NIC drivers, quick install guide, product warranty statement

Technical Specifications - Networking and Communications

HP X520 10GbE Dual Port Hardware Certifications FCC B, UL, CE, VCCI, BSMI, CTICK, KCC

Adapter

HP 10GbE SFP+ SR

Transceiver

Operating Temperature
Operating Humidity

Dimensions (H x W x D)

0°C to 45°C (32°F to 113°F) 0% to 85%, noncondensing

0.47(h) x 0.54(w) x 2.19(d)inches

(1.19 x 1.38 x 5.57 cm)

HP 361T PCIe Dual Port Gigabit NIC

Connector

Two RJ-45

Controller

Intel® Ethernet I350 Controller

Data Rates Supported

10/100/1000 Mbps, Half- and full-duplex

Compliance

802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q, 802.3az, IEEE 1588

PCIe v2.0 standard RoHS (6 of 6)

FCC (U.S. only) Class B DOC (Canada) Class B

CE EN 55024, EN55022 Class B

VCCI Class II UL 1950 CSA 950 EN 60950 CE ACPI 1.1a

Microsoft WHQL (Windows Hardware Quality Labs)

Bus Architecture PCI-E 1.0a

Data Path Width Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI Express slots

Power Requirement 4.1W idle without EEE link partner

3.2W idle with EEE link partner

4.2W maximum

Network Transfer Rate 10BASE-T (half-duplex) 10 Mb/s

10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s

Operating Temperature 32° to 131°F (0° to 55° C)
Operating Humidity 10% to 95% non-condensing

Dimensions (H x W x D) 5.3 x 2.5 in (13.50 cm x 6.4 cm) (without brackets)

Operating System Driver

Support

Windows 7 Professional 32-bit and 64-bit.

Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

Management Capabilities WOL, PXE 2.1

Technical Specifications - Networking and Communications

Kit Contents

HP 361T PCIe Dual Port Gigabit NIC PCA with a standard height bracket attached to it (the low profile bracket is included in the clamshell that the PCA

ships in)

Product Warranty statement and the Quick Install Card (QIC).

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